



**SiI 163B**  
**PanelLink Receiver**  
**Data Sheet**

Document # SiI-DS-0055-C

## Silicon Image, Inc.

SiI-DS-0055-C  
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### Revision History

| Revision      | Date  | Comment                                                       |
|---------------|-------|---------------------------------------------------------------|
| SiI-DS-0055-A | 03/02 | Full Release                                                  |
| SiI-DS-0055-B | 08/04 | Added ePad dimensions and Slave SCDT stabilization guideline. |
| SiI-DS-0055-C | 07/05 | ePad dimensions fix. Part ordering number update.             |

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## General Description

The SiI 163B receiver uses PanelLink Digital technology to support high-resolution (24 bit/pixel, 16M colors) displays up to UXGA and beyond, with dual-link DVI for a total bandwidth up to 330 megapixels per second.

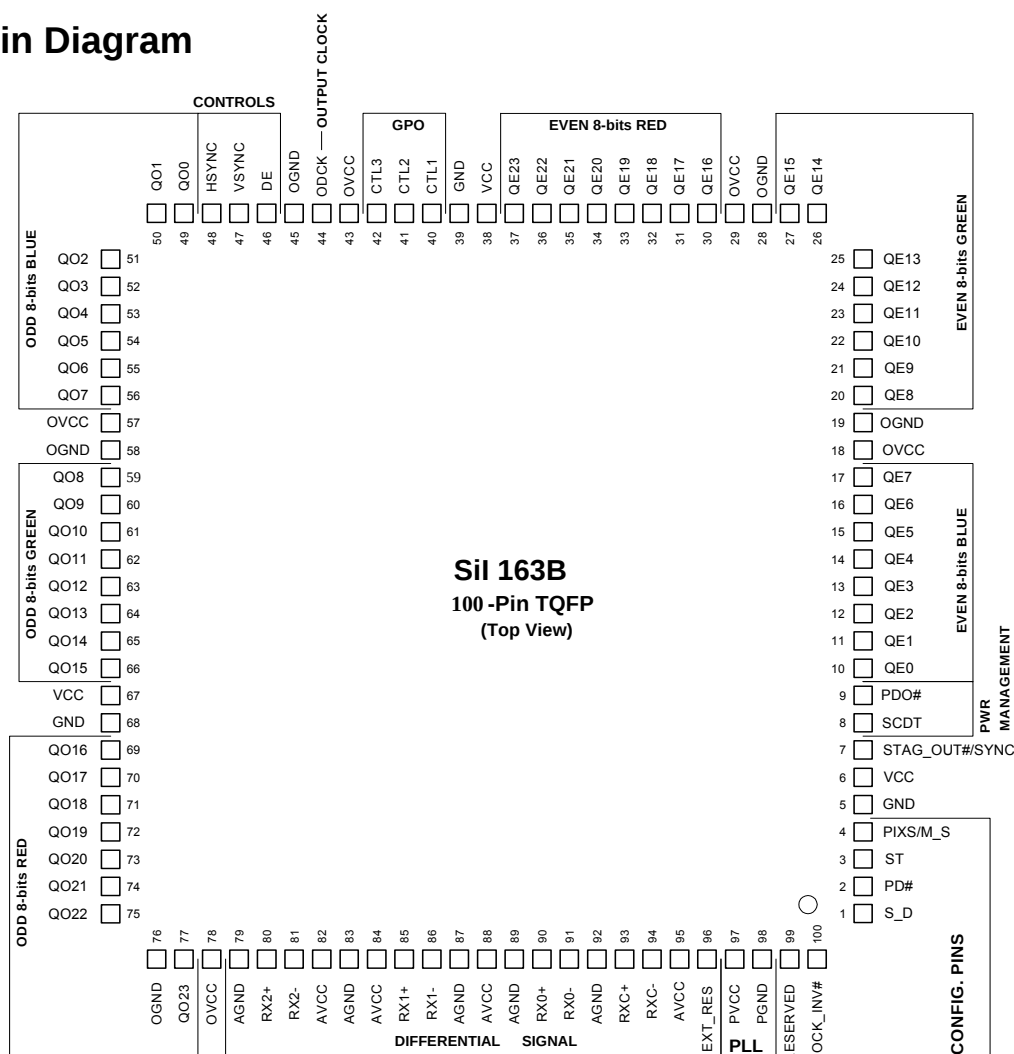
All PanelLink products are designed on a scaleable CMOS architecture, ensuring support for future performance enhancements while maintaining the same logical interface. System designers can be assured that the interface will be stable through a number of technology and performance generations.

PanelLink Digital technology simplifies PC and display interface design by resolving many of the system level issues associated with high-speed mixed signal design, providing the system designer with a digital interface solution that is quicker to market and lower in cost.

## Features

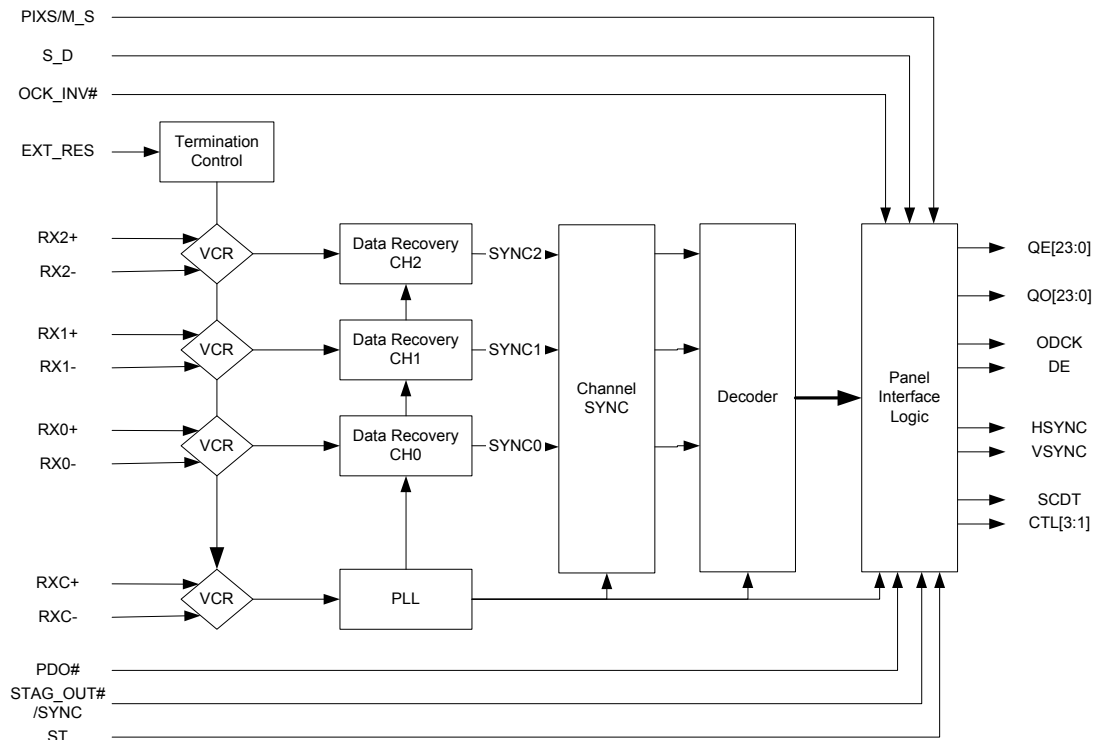
- Low Power Operation: 280mA max. current consumption at 3.3V core operation
- Sync Detect feature for Plug & Display "Hot Plugging"
- Cable Distance Support: over 5m with twisted-pair, fiber-optics ready
- Compliant with DVI 1.0
- Low power standby mode
- Automatic entry into standby mode with clock detect circuitry
- Dual-Link DVI support with two devices configured as master and slave

## SiI 163B Pin Diagram



## Functional Description

The SiI 163B is a DVI 1.0 compliant PanelLink receiver in a compact package. It provides 48 bits for data output to allow for panel support up to UXGA and dual-link applications. Figure 1 shows the functional blocks of the chip.



**Figure 1. Functional Block Diagram**

The PanelLink TMDS core accepts as inputs the three TMDS differential data lines and the differential clock. The core senses the signals on the link and properly decodes them providing accurate pixel data. The core outputs the necessary sync signals (HSYNC, VSYNC), clock (ODCK), and a DE signal that goes high when the active region of the video is present.

The SCDT signal is output when there is active video on the DVI link and the PLL in the TMDS has locked on to the video. SCDT can be used to trigger external circuitry, indicating that an active video signal is present or used to place the device in power down when no signal is present (by tying it to PD#). The EXT\_RES component is used for impedance matching.

When Single/Dual Link Mode (S\_D) is HIGH, the signals M\_S and SYNC are used to select and coordinate operation of two receivers in a dual-link DVI configuration. In this mode, at frequencies up to 165 MHz, the master receiver outputs two pixels/clock (48 data bits). At frequencies above 165 MHz, the master outputs even pixels (24 bits) while the slave receiver outputs odd pixels (24 bits) synchronized with one DE output from the master.

## Electrical Specifications

### Absolute Maximum Conditions

| Symbol    | Parameter                    | Min  | Typ | Max            | Units |
|-----------|------------------------------|------|-----|----------------|-------|
| $V_{CC}$  | Supply Voltage 3.3V (note 1) | -0.3 |     | 4.0            | V     |
| $V_I$     | Input Voltage                | -0.3 |     | $V_{CC} + 0.3$ | V     |
| $V_O$     | Output Voltage (note 2)      | -0.3 |     | $V_{CC} + 0.3$ | V     |
| $T_J$     | Junction Temperature         |      |     | 125            | °C    |
| $T_{STG}$ | Storage Temperature          | -65  |     | 150            | °C    |

#### Notes

1. Permanent device damage may occur if absolute maximum conditions are exceeded.
2. Functional operation should be restricted to the conditions described under Normal Operating Conditions.

### Normal Operating Conditions

| Symbol         | Parameter                                                   | Min | Typ | Max | Units             |
|----------------|-------------------------------------------------------------|-----|-----|-----|-------------------|
| $V_{CC}$       | Supply Voltage                                              | 3.0 | 3.3 | 3.6 | V                 |
| $V_{CCN}$      | Supply Voltage Noise                                        |     |     | 100 | mV <sub>P-P</sub> |
| $T_A$          | Ambient Temperature (with power applied)                    | 0   | 25  | 70  | °C                |
| $\theta_{JA}$  | Thermal Resistance<br>Junction to Ambient – ePad soldered   |     | 21  |     | °C/W              |
| $\theta_{JAU}$ | Thermal Resistance<br>Junction to Ambient – ePad unsoldered |     | 30  |     | °C/W              |

Silicon Image recommends soldering of ePad to improve thermal performance, especially at highest speeds.

#### Note

1.  $\theta_{JA}$  value based on 100% soldered down on multi-layer board.

### Digital I/O Specifications

Under normal operating conditions unless otherwise specified.

| Symbol     | Parameter                         | Conditions       | Min | Typ | Max        | Units |
|------------|-----------------------------------|------------------|-----|-----|------------|-------|
| $V_{IH}$   | High-level Input Voltage          |                  | 2   |     |            | V     |
| $V_{IL}$   | Low-level Input Voltage           |                  |     |     | 0.8        | V     |
| $V_{OH}$   | High-level Output Voltage         |                  | 2.4 |     |            | V     |
| $V_{OL}$   | Low-level Output Voltage          |                  |     |     | 0.4        | V     |
| $V_{CINL}$ | Input Clamp Voltage <sup>1</sup>  | $I_{CL} = -18mA$ |     |     | GND -0.8   | V     |
| $V_{CIPL}$ | Input Clamp Voltage <sup>1</sup>  | $I_{CL} = 18mA$  |     |     | IVCC + 0.8 | V     |
| $V_{CONL}$ | Output Clamp Voltage <sup>1</sup> | $I_{CL} = -18mA$ |     |     | GND -0.8   | V     |
| $V_{COPL}$ | Output Clamp Voltage <sup>1</sup> | $I_{CL} = 18mA$  |     |     | OVCC + 0.8 | V     |
| $I_{OL}$   | Output Leakage Current            | High Impedance   | -10 |     | 10         | μA    |

#### Note

1. Guaranteed by design. Voltage undershoot or overshoot cannot exceed absolute maximum conditions for a pulse of greater than 3 ns or one third of the clock cycle.

## DC Specifications

Under normal operating conditions unless otherwise specified.

| Symbol     | Parameter                                         | Conditions                                                                                                                                    | Min            | Typ            | Max            | Units |
|------------|---------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------|----------------|----------------|----------------|-------|
| $I_{OHD}$  | Output High Drive Data and Controls               | $V_{OUT} = 2.4\text{ V}; ST = 1$<br>$ST = 0$                                                                                                  | 7.4<br>3.8     | 12.6<br>6.4    | 18.2<br>9.2    | mA    |
| $I_{OLD}$  | Output Low Drive Data and Controls                | $V_{OUT} = 0.8\text{ V}; ST = 1$<br>$ST = 0$                                                                                                  | -11.1<br>-5.5  | -12.6<br>-6.4  | -13.6<br>-6.9  | mA    |
|            |                                                   | $V_{OUT} = 0.4\text{ V}; ST = 1$<br>$ST = 0$                                                                                                  | -6.3<br>-3.2   | -6.9<br>-3.5   | -7.6<br>-3.8   | mA    |
| $I_{OHC}$  | ODCK, DE High Drive                               | $V_{OUT} = 2.4\text{ V}; ST = 1$<br>$ST = 0$                                                                                                  | 14.7<br>7.5    | 23.8<br>11.5   | 34.3<br>17.6   | mA    |
| $I_{OLC}$  | ODCK, DE Low Drive                                | $V_{OUT} = 0.8\text{ V}; ST = 1$<br>$ST = 0$                                                                                                  | -21.2<br>-11.1 | -26.7<br>-12.5 | -27.5<br>-13.9 | mA    |
|            |                                                   | $V_{OUT} = 0.4\text{ V}; ST = 1$<br>$ST = 0$                                                                                                  | -12.3<br>-6.2  | -13.6<br>-6.8  | -15.9<br>-7.6  | mA    |
| $V_{ID}$   | Differential Input Voltage Single Ended Amplitude |                                                                                                                                               | 75             |                | 1000           | mV    |
| $I_{PD}$   | Power-down Current                                | PD#=LOW, No RXC+ input                                                                                                                        |                |                | 1              | mA    |
| $I_{CLKI}$ | Power-down Current                                | PD#=HIGH, No RXC+ input                                                                                                                       |                |                | 3              | mA    |
| $I_{PDO}$  | Receiver Supply Current with Outputs Powered Down | ODCK=87.5 MHz,<br>2-pixel/clock mode<br>$C_{LOAD} = 10\text{ pF}$<br>$R_{EXT\_SWING} = 510\text{ ohm}$<br>PDO# = LOW                          |                |                | 133            | mA    |
| $I_{CCR}$  | Receiver Supply Current                           | ODCK=87.5 MHz,<br>2-pixel/clock mode<br>$C_{LOAD} = 10\text{ pF}$<br>$R_{EXT\_SWING} = 510\text{ ohm}$<br>Typical Pattern <sup>1</sup>        |                |                | 240            | mA    |
|            |                                                   | ODCK=87.5 MHz, 0°C<br>2-pixel/clock mode<br>$C_{LOAD} = 10\text{ pF}$<br>$R_{EXT\_SWING} = 510\text{ ohm}$<br>Worst Case Pattern <sup>2</sup> |                |                | 280            | mA    |

### Notes

1. The Typical Pattern contains a gray scale area, checkerboard area, and text.
2. The Worst Case Pattern consists of a black and white checkerboard pattern; each checker is two pixels wide.

## AC Specifications

Under normal operating conditions unless otherwise specified.

| Symbol             | Parameter                                                                                                                               | Conditions                    | Min                       | Typ  | Max  | Units            |
|--------------------|-----------------------------------------------------------------------------------------------------------------------------------------|-------------------------------|---------------------------|------|------|------------------|
| T <sub>DPS</sub>   | Intra-Pair (+ to -) Differential Input Skew <sup>1</sup>                                                                                | 165MHz                        |                           |      | 245  | ps               |
| T <sub>CCS</sub>   | Channel to Channel Differential Input Skew <sup>1</sup>                                                                                 | 165MHz                        |                           |      | 4    | ns               |
| T <sub>IJIT</sub>  | Worst Case Differential Input Clock Jitter tolerance <sup>2,3</sup>                                                                     | 65 MHz                        |                           |      | 465  | ps               |
|                    |                                                                                                                                         | 112 MHz                       |                           |      | 270  | ps               |
|                    |                                                                                                                                         | 165 MHz                       |                           |      | 182  | ps               |
| D <sub>LHT</sub>   | Low-to-High Transition Time: Data and Controls (70°C, 87.5 MHz, 2-pixel/clock, PIXS=1)                                                  | C <sub>L</sub> = 10pF; ST = 1 |                           |      | 2.6  | ns               |
|                    |                                                                                                                                         | C <sub>L</sub> = 5pF; ST = 0  |                           |      | 2.7  | ns               |
|                    | Low-to-High Transition Time: Data and Controls (70°C, 165 MHz, 1-pixel/clock, PIXS=0)                                                   | C <sub>L</sub> = 10pF; ST = 1 |                           |      | 2.4  | ns               |
|                    |                                                                                                                                         | C <sub>L</sub> = 5pF; ST = 0  |                           |      | 3.0  | ns               |
|                    | Low-to-High Transition Time: ODCK (70°C, 87.5 MHz, 2-pixel/clock, PIXS=1)                                                               | C <sub>L</sub> = 10pF; ST = 1 |                           |      | 1.3  | ns               |
|                    |                                                                                                                                         | C <sub>L</sub> = 5pF; ST = 0  |                           |      | 1.7  | ns               |
| D <sub>HLT</sub>   | High-to-Low Transition Time: Data and Controls (70°C, 87.5 MHz, 2-pixel/clock, PIXS=1)                                                  | C <sub>L</sub> = 10pF; ST = 1 |                           |      | 2.8  | ns               |
|                    |                                                                                                                                         | C <sub>L</sub> = 5pF; ST = 0  |                           |      | 3.4  | ns               |
|                    | High-to-Low Transition Time: Data and Controls (70°C, 165 MHz, 1-pixel/clock, PIXS=0)                                                   | C <sub>L</sub> = 10pF; ST = 1 |                           |      | 2.3  | ns               |
|                    |                                                                                                                                         | C <sub>L</sub> = 5pF; ST = 0  |                           |      | 3.3  | ns               |
|                    | High-to-Low Transition Time: ODCK (70°C, 87.5 MHz, 2-pixel/clock, PIXS=1)                                                               | C <sub>L</sub> = 10pF; ST = 1 |                           |      | 1.1  | ns               |
|                    |                                                                                                                                         | C <sub>L</sub> = 5pF; ST = 0  |                           |      | 1.5  | ns               |
| T <sub>SETUP</sub> | Data, DE, VSYNC, HSYNC, and CTL[3:1] Setup Time to ODCK falling edge (OCK_INV# = 0) or to ODCK rising edge (OCK_INV# = 1) at 165 MHz    | C <sub>L</sub> = 10pF; ST = 1 | 0.9<br>(1.4) <sup>6</sup> |      |      | ns               |
|                    |                                                                                                                                         | C <sub>L</sub> = 5pF; ST = 0  | 0.7<br>(0.5) <sup>6</sup> |      |      | ns               |
| T <sub>HOLD</sub>  | Data, DE, VSYNC, HSYNC, and CTL[3:1] Hold Time from ODCK falling edge (OCK_INV# = 0) or from ODCK rising edge (OCK_INV# = 1) at 165 MHz | C <sub>L</sub> = 10pF; ST = 1 | 2.7<br>(2.3) <sup>6</sup> |      |      | ns               |
|                    |                                                                                                                                         | C <sub>L</sub> = 5pF; ST = 0  | 3.0<br>(2.6) <sup>6</sup> |      |      | ns               |
| R <sub>CIP</sub>   | ODCK Cycle Time <sup>1</sup> (1-pixel/clock)                                                                                            |                               | 6.06                      |      | 40   | ns               |
| F <sub>CIP</sub>   | ODCK Frequency <sup>1</sup> (1-pixel/clock)                                                                                             |                               | 25                        |      | 165  | MHz              |
| R <sub>CIP</sub>   | ODCK Cycle Time <sup>1</sup> (2-pixels/clock)                                                                                           |                               | 12.1                      |      | 80   | ns               |
| F <sub>CIP</sub>   | ODCK Frequency <sup>1</sup> (2-pixels/clock)                                                                                            |                               | 12.5                      |      | 82.5 | MHz              |
| R <sub>CIH</sub>   | ODCK High Time <sup>4</sup> 165 MHz, 1 pixel/clock, PIXS=0.                                                                             | C <sub>L</sub> = 10pF; ST = 1 | 1.7                       |      |      | ns               |
|                    |                                                                                                                                         | C <sub>L</sub> = 5pF; ST = 0  | 1.3                       |      |      | ns               |
| R <sub>CIL</sub>   | ODCK Low Time <sup>4</sup>                                                                                                              | C <sub>L</sub> = 10pF; ST = 1 | 2.0                       |      |      | ns               |
|                    |                                                                                                                                         | C <sub>L</sub> = 5pF; ST = 0  | 1.4                       |      |      | ns               |
| T <sub>PDL</sub>   | Delay from PD# / PDO# Low to high impedance outputs <sup>1</sup>                                                                        |                               |                           |      | 10   | ns               |
| T <sub>HSC</sub>   | Link disabled (DE inactive) to SCDT low <sup>1</sup>                                                                                    |                               |                           | 100  |      | ms               |
|                    | Link disabled (Tx power down) to SCDT low <sup>5</sup>                                                                                  |                               |                           |      | 250  | ms               |
| T <sub>FSC</sub>   | Link enabled (DE active) to SCDT high <sup>1</sup>                                                                                      |                               |                           | 25   | 40   | DEedges          |
| T <sub>CLKPD</sub> | Delay from RXC <sub>±</sub> Inactive to high impedance outputs                                                                          | RXC <sub>±</sub> = 25MHz      |                           |      | 10   | μs               |
| T <sub>CLKPU</sub> | Delay from RXC <sub>±</sub> active to data active                                                                                       | RXC <sub>±</sub> = 25MHz      |                           |      | 100  | μs               |
| T <sub>ST</sub>    | ODCK high to even data output <sup>1</sup>                                                                                              |                               |                           | 0.25 |      | R <sub>CIP</sub> |
| T <sub>OSK</sub>   | Output Skew from Slave to Master Data buses <sup>7</sup>                                                                                | 165 MHz                       | 300                       |      | 300  | ps               |

**Notes on previous table:**

1. Guaranteed by design.
2. Jitter defined per DVI 1.0 Specification, Section 4.6 – Jitter Specification.
3. Jitter measured with Clock Recovery Unit per DVI 1.0 Specification, Section 4.7 – Electrical Measurement Procedures.
4. Output clock duty cycle is independent of the differential input clock duty cycle and the ODCK duty cycle.
5. Measured with transmitter powered down.
6. Value in parentheses is specified with OCK\_INV#=1.
7. Skew between output data buses when two SiI 163B are wired in master-slave configuration for dual-link. See the Receiver Layout section on page 30. The 'minimum' is the limit of Slave leading Master (slave data output earlier than master data). The 'maximum' is the limit of Slave lagging Master (slave data output later than master data). When the Slave lags the Master, then the setup time available from Slave data to ODCK (from the Master) is reduced.

**Setup and Hold Timings for Data Rates other than 165 MHz**

The measurements shown above are minimum setup and hold timings based on the maximum data rate of 165 MHz. To estimate the setup and hold times for slower data rates (for either different resolutions or 2 pixel per clock mode), the following formula can be used:

$$\text{Time (at new frequency)} = \text{Time (165 MHz)} + (\text{Clock Period at new frequency} - \text{Clock Period at 165 MHz})/2$$

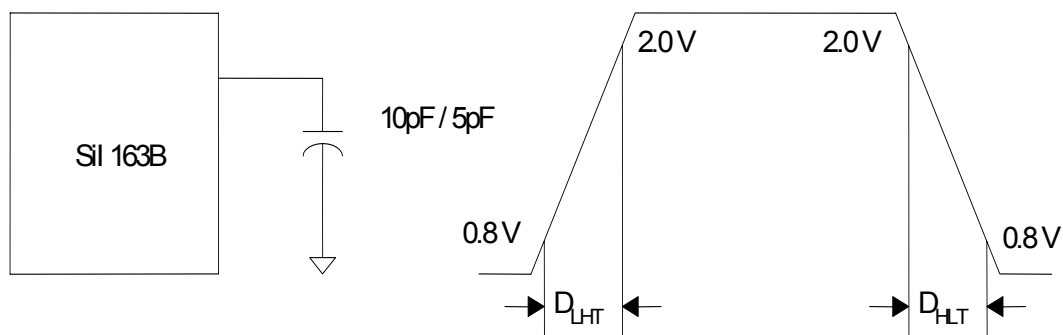
For the case of high strength output (ST=1) with a 10pf load, and using the standard ODCK (OCK\_INV# = 0), Table 1 shows the minimum set up and hold times for other speeds as follows:

**Table 1. Setup and Hold Times at Various Data Rates**

| Data Rate (MHz) | Clock (ns) | Setup (ns) | Hold (ns) |                      |
|-----------------|------------|------------|-----------|----------------------|
| 112             | 8.9        | 2.3        | 4.1       | SXGA 1 pixel/clock   |
| 56              | 17.9       | 6.8        | 8.6       | SXGA 2 pixels/clock  |
| 135             | 7.4        | 1.6        | 3.4       | SXGA+ 1 pixel/clock  |
| 67.5            | 14.8       | 5.3        | 7.1       | SXGA+ 2 pixels/clock |
| 82.5            | 12.1       | 3.9        | 5.7       | UXGA 2 pixels/clock  |

Designers may want to check whether OCK+INV#=0 or OCK\_INV#=1 provides better setup and hold time margin for their dual-link design. If Slave data lags Master data, which is in part determined by the layout, then the setup time from Slave to clock may be reduced, and the opposite ODCK edge may be more useful.

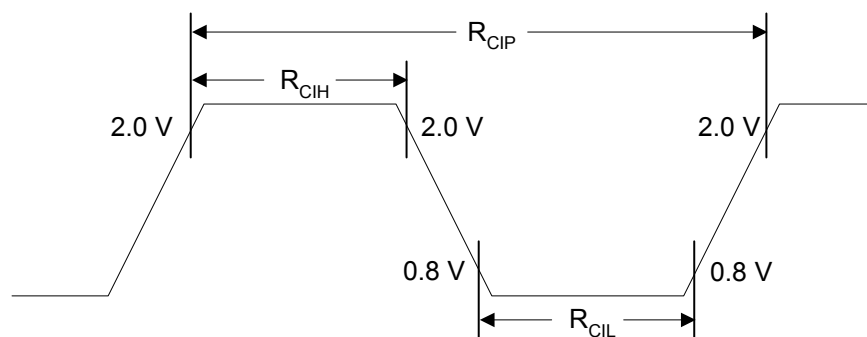
## Timing Diagrams



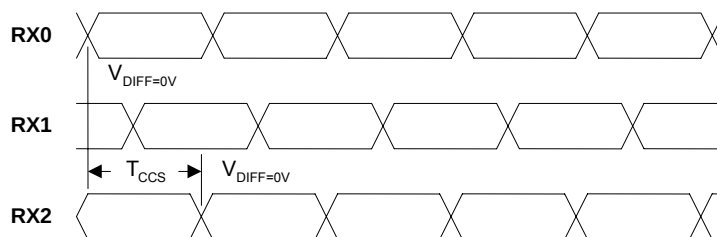
**Figure 2. Digital Output Transition Times**

Note:

1. 10pF loading used at ST=1 and 5pF loading using at ST=0

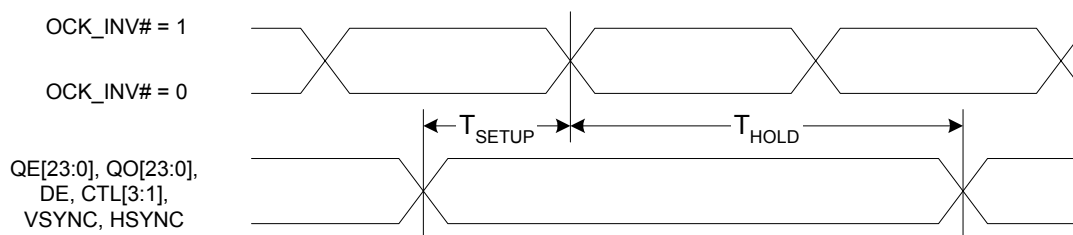


**Figure 3. Receiver Clock Cycle/High/Low Times**



**Figure 4. Channel-to-Channel Skew Timing**

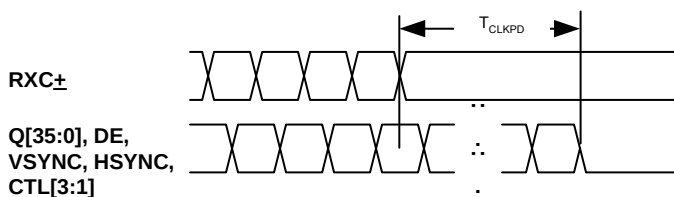
## Output Timing



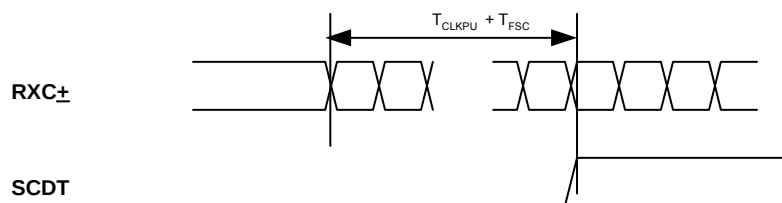
**Figure 5. Output Setup/Hold Timings**

### Note

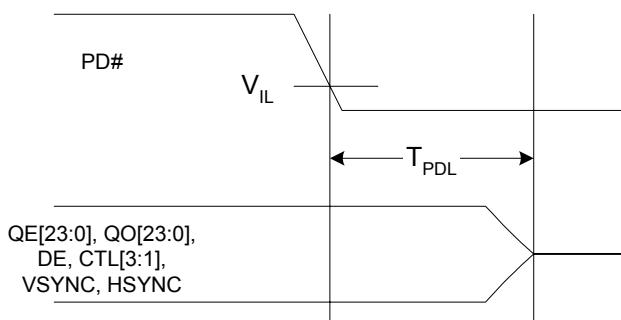
1. Output Data, DE and Control Signals Setup/Hold Times – to ODCK Falling Edge when OCK\_INV# = 0, or to ODCK Rising Edge when OCK\_INV# = 1.
2. See also the description of layout guidelines which guarantee limited skew between master and slave outputs in the Receiver Layout section on page 30.



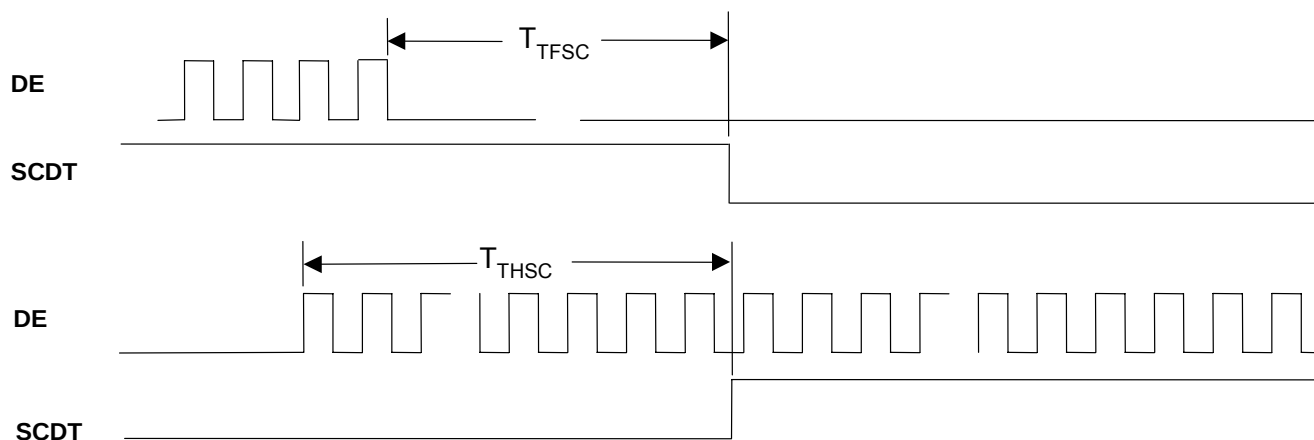
**Figure 6. Output Signals Disabled Timing from Clock Inactive**



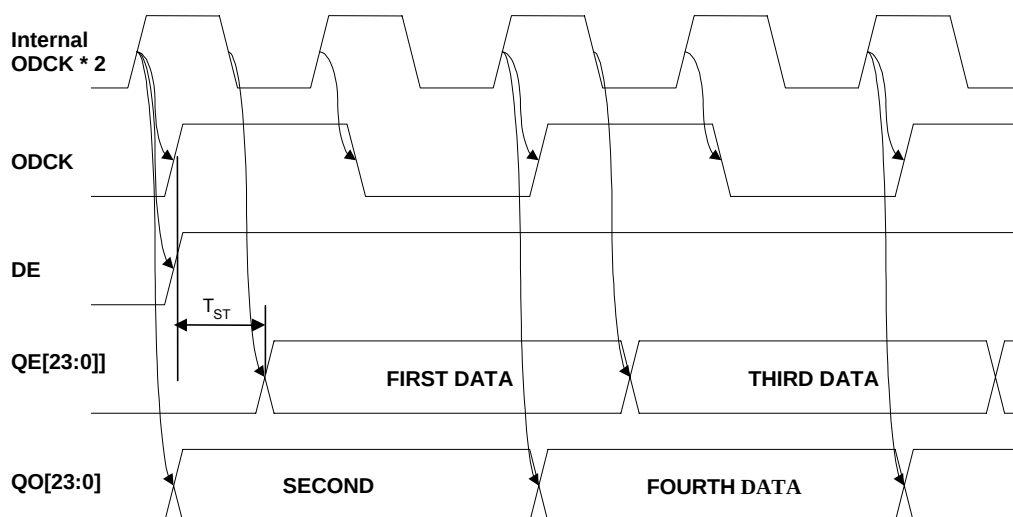
**Figure 7. Wake-Up on Clock Detect**



**Figure 8. Output Signals Disabled Timing from PD# Active**



**Figure 9. SCDT Timing from DE Inactive or Active**



**Figure 10. Two Pixel per Clock Staggered Output Timing Diagram**

## Pin Descriptions

### Output Pins

| Pin Name | Pin #                    | Type | Description                                                                                                                                                                                                                                                                                                                                                              |
|----------|--------------------------|------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| QE23-QE0 | See SiI 163B Pin Diagram | Out  | Output Even Data[23:0]. Refer to the Dual Link section on page 13 for details. Output data is synchronized with output data clock (ODCK).                                                                                                                                                                                                                                |
|          |                          |      | Refer to the TFT Panel Data Mapping section on page 20, which tabulates the relationship between the input data to the transmitter and output data from the receiver.                                                                                                                                                                                                    |
|          |                          |      | A low level on PD# or PDO# will put the output drivers into a high impedance (tri-state) mode. A weak internal pull-down device brings each output to ground.                                                                                                                                                                                                            |
| QO23-QO0 | See SiI 163B Pin Diagram | Out  | Output Odd Data[23:0]. Refer to the Dual Link section on page 13 for details. Output data is synchronized with output data clock (ODCK).                                                                                                                                                                                                                                 |
|          |                          |      | Output data is synchronized with output data clock (ODCK).                                                                                                                                                                                                                                                                                                               |
|          |                          |      | Refer to the TFT Panel Data Mapping section on page 20, which tabulates the relationship between the input data to the transmitter and output data from the receiver.                                                                                                                                                                                                    |
|          |                          |      | A low level on PD# or PDO# will put the output drivers into a high impedance (tri-state) mode. A weak internal pull-down device brings each output to ground.                                                                                                                                                                                                            |
|          |                          |      |                                                                                                                                                                                                                                                                                                                                                                          |
|          |                          |      |                                                                                                                                                                                                                                                                                                                                                                          |
| ODCK     | 44                       | Out  | Output Data Clock. This output can be inverted using the OCK_INV# pin. A low level on PD# or PDO# will put the output driver into a high impedance (tri-state) mode. A weak internal pull-down device brings the output to ground.                                                                                                                                       |
| DE       | 46                       | Out  | Output Data Enable. This signal qualifies the active data area. A HIGH level signifies active display time and a LOW level signifies blanking time. This output signal is synchronized with the output data. A low level on PD# or PDO# will put the output driver into a high impedance (tri-state) mode. A weak internal pull-down device brings the output to ground. |
| HSYNC    | 48                       | Out  | Horizontal Sync input control signal.                                                                                                                                                                                                                                                                                                                                    |
| VSYNC    | 47                       | Out  | Vertical Sync input control signal.                                                                                                                                                                                                                                                                                                                                      |
| CTL1     | 40                       | Out  | General output control signal 1. This output is <b>not</b> powered down by PDO#.                                                                                                                                                                                                                                                                                         |
| CTL2     | 41                       | Out  | General output control signal 2.                                                                                                                                                                                                                                                                                                                                         |
| CTL3     | 42                       | Out  | General output control signal 3.                                                                                                                                                                                                                                                                                                                                         |
|          |                          |      | A low level on PD# or PDO# will put the output drivers (except CTL1 by PDO#) into a high impedance (tri-state) mode. A weak internal pull-down device brings each output to ground.                                                                                                                                                                                      |

## Configuration Pins

| Pin Name           | Pin # | Type | Description                                                                                                                                                                                                                                                                                                                                                                                                           |
|--------------------|-------|------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| OCK_INV#           | 100   | In   | ODCK Polarity. A LOW level selects normal ODCK output. A HIGH level selects inverted ODCK output. All other output signals are unaffected by this pin. They will maintain the same timing no matter the setting of OCK_INV# pin                                                                                                                                                                                       |
| PIXS/M_S           | 4     | In   | When S_D pin is LOW (Single Link), this pin selects 1-pixel/clock mode (LOW) or 2-pixel/clock mode (HIGH). When S_D pin is HIGH (Dual Link), this pin is Master Slave Mode Select.                                                                                                                                                                                                                                    |
| STAG_OUT#<br>/SYNC | 7     | In   | When S_D pin is LOW (Single Link), this pin selects Staggered Output. A HIGH level selects normal simultaneous outputs on all odd and even data lines. A LOW level selects staggered output drive. This function is only available in 2-pixels per clock mode. When S_D pin is HIGH (Dual Link), this pin is an input pin on the Slave receiver for the DE signal from the master receiver, used for synchronization. |
| ST                 | 3     | In   | Output Drive. A HIGH level selects HIGH output drive strength. A LOW level selects LOW output drive strength.                                                                                                                                                                                                                                                                                                         |
| S_D                | 1     | In   | Single/Dual Link Mode. A LOW level selects Single Link mode. A HIGH level selects Dual Link mode. This affects the operation of SYNC, M_S and the two 24-bit data output buses.                                                                                                                                                                                                                                       |

## Power Management Pins

| Pin Name | Pin # | Type | Description                                                                                                                                                                                                                                                                                                                                                                                          |
|----------|-------|------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| SCDT     | 8     | Out  | Sync Detect. A HIGH level is outputted when DE is actively toggling indicating that the link is alive. A LOW level is outputted when DE is inactive, indicating the link is down. Can be connected to PDO# to power down the outputs when DE is not detected. The SCDT output itself, however, remains in the active mode at all times.                                                              |
| PDO#     | 9     | In   | Output Driver Power Down (active LOW). A HIGH level indicates normal operation. A LOW level puts all the output drivers only (except SCDT and CTL1) into a high impedance (tri-state) mode. A weak internal pull-down device brings each output to ground. PDO# is a sub-set of the PD# description. The chip is not in power-down mode with this pin. SCDT and CTL1 are not tri-stated by this pin. |
| PD#      | 2     | In   | Power Down (active LOW). A HIGH level indicates normal operation. A LOW level indicates power down mode. During power down mode, all the output drivers are put into a high impedance (tri-state) mode. A weak internal pull-down device brings each output to ground. Additionally, all analog logic is powered down, and all inputs are disabled.                                                  |

## Differential Signal Data Pins

| Pin Name | Pin # | Type   | Description                                                                                           |
|----------|-------|--------|-------------------------------------------------------------------------------------------------------|
| RX0+     | 90    | Analog | TMDS Low Voltage Differential Signal input data pairs.                                                |
| RX0-     | 91    | Analog |                                                                                                       |
| RX1+     | 85    | Analog |                                                                                                       |
| RX1-     | 86    | Analog |                                                                                                       |
| RX2+     | 80    | Analog |                                                                                                       |
| RX2-     | 81    | Analog |                                                                                                       |
| RXC+     | 93    | Analog | TMDS Low Voltage Differential Signal input clock pair.                                                |
| RXC-     | 94    | Analog |                                                                                                       |
| EXT_RES  | 96    | Analog | Impedance Matching Control. An external 390 ohm resistor must be connected between AVCC and this pin. |

## Reserved Pin

| Pin Name | Pin # | Type | Description                             |
|----------|-------|------|-----------------------------------------|
| RESERVED | 99    | In   | Must be tied HIGH for normal operation. |

## Power and Ground Pins

| Pin Name | Pin #          | Type   | Description                            |
|----------|----------------|--------|----------------------------------------|
| VCC      | 6,38,67        | Power  | Digital Core VCC, must be set to 3.3V. |
| GND      | 5,39,68        | Ground | Digital Core GND.                      |
| OVCC     | 18,29,43,57,78 | Power  | Output VCC, must be set to 3.3V.       |
| OGND     | 19,28,45,58,76 | Ground | Output GND.                            |
| AVCC     | 82,84,88,95    | Power  | Analog VCC must be set to 3.3V.        |
| AGND     | 79,83,87,89,92 | Ground | Analog GND.                            |
| PVCC     | 97             | Power  | PLL Analog VCC must be set to 3.3V.    |
| PGND     | 98             | Ground | PLL Analog GND.                        |

## Feature Information

The SiI 163B can be configured in two modes: Single Link and Dual Link. When in Single Link (S\_D is LOW), the device operates in either 1-pixel/clock or 2-pixel/clock mode, according to the state of the PIXS pin. There is no communication with a second receiver. In this mode, the SiI 163B operates in the same way as the other PanelLink receivers: SiI 143B, SiI 151B, SiI 153B and SiI 161B.

In Dual Link mode, two SiI 163B's operate together to handle bandwidths up to 330 megapixels per second. The configuration and management of this mode is detailed in the following sections. Dual Link mode may operate across a pixel frequency of 25 MHz to 330 MHz. Below 165 MHz, the second TMDS channel is quiescent. All pixel data is sent across the first TMDS channel, and handled by the Master SiI 163B receiver. Above 165 MHz, both SiI 163B receivers are active, with the pixels alternating even-and-odd from Master to Slave, driven by the two TMDS DVI channels.

## Dual Link

Two SiI 163B's are required for a DVI compatible Dual Link application as configured in the block diagram of Figure 11. At pixel frequencies up to 165 MHz, the system does not send any data over the second link connected to the Slave receiver. Therefore, the Slave receiver is not active and its outputs are tri-stated. All the data, both EVEN and ODD pixels, are sent over the TMDS link connected to the Master receiver. Therefore all the data, both EVEN and ODD pixels, is output by the Master receiver.

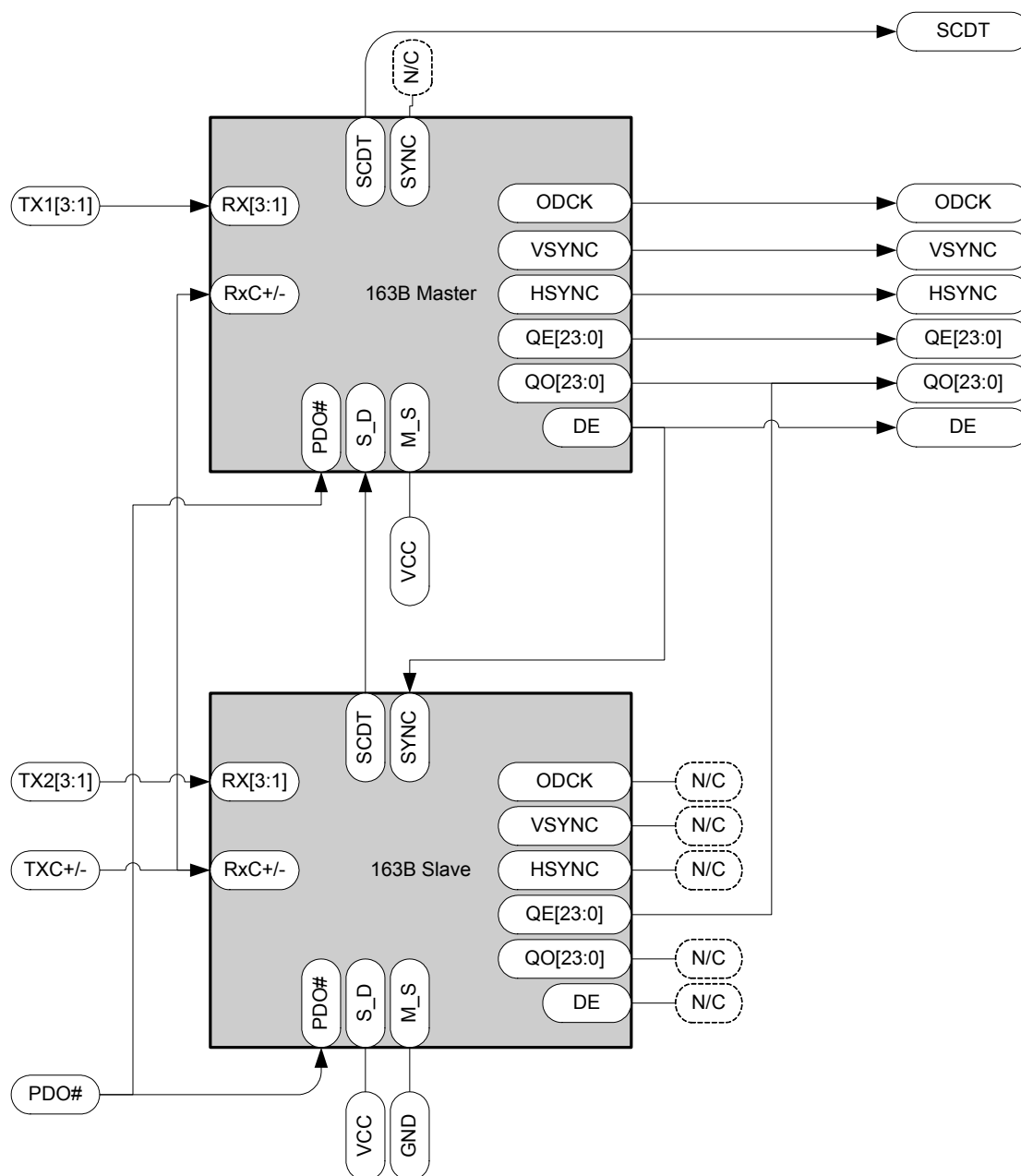
At pixel frequencies above 165 MHz, the system sends EVEN data over the link connected to the Master receiver and the ODD data over the link connected to the Slave receiver. Therefore, the EVEN data is output by the Master receiver and the ODD data is output by the Slave receiver. The Master receiver's ODD data bus is tri-stated to allow the Slave receiver's EVEN Data bus to output the ODD data.

## Dual Link Configuration Pins

Five pins on the SiI 163B need to be considered for Dual Link receiver applications.

**Table 2. SiI 163B Dual Link Pin Definitions**

| Pin Name        | Pin # | Type | Description                                                                                                                                                                                                                                                                                                                                                 |
|-----------------|-------|------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| S_D             | 1     | In   | Single/Dual Link Mode. When HIGH, it is in Dual Link Mode. When LOW it is in Single Link Mode. The Slave receiver is always in Dual Link mode. The Master receiver switches between Single and Dual Link mode depending upon the SCDT output of the Slave receiver that is connected to the S_D input of the Master receiver.                               |
| PIXS / M_S      | 4     | In   | Master/Slave. When S_D pin is HIGH (Dual Link), this pin becomes M_S. When HIGH, it is in Master mode. When LOW, it is in Slave mode. The Master receiver is in one/two-pixels per clock mode depending upon Single/Dual Link operation. The Slave receiver is always in one-pixel per clock mode.<br>When S_D is LOW (Single Link), this pin becomes PIXS. |
| STAG_OUT / SYNC | 7     | In   | Synchronization. When S_D pin is HIGH (Dual Link), this pin is used to synchronize the Slave receiver to the Master receiver. The SYNC input pin of the Slave receiver is connected to the DE output pin of the Master receiver.                                                                                                                            |
| SCDT            | 8     | Out  | Sync Detect. When HIGH, there are valid sync signals coming from the transmitter. When LOW, there are no sync signals coming from the transmitter. The SCDT pin of the Slave receiver is connected to the S_D pin of the Master receiver.                                                                                                                   |
| DE              | 46    | Out  | Data Enable. This signal qualifies the active data area. A HIGH level signifies active display time and a LOW level signifies blanking time. This output signal is synchronized with the output data.<br>The DE output pin of the Master is connected to the SYNC input pin of the Slave.                                                                   |



**Figure 11. SiI 163B Dual Link Block Diagram**

#### Master –

The Master receiver will automatically configure to either Single or Dual Link operation (two or one pixel per clock mode, respectively) depending on the transmitter system output. This is accomplished by connecting the SCDT output pin of the Slave to the S\_D pin on the Master. When the transmitter sends data on the second link, the SCDT output of the slave (and the S\_D pin on the Master) is driven HIGH, setting to Dual Link (one-pixel per clock) mode. If there is no data on the second link, the SCDT output of the Slave (and the S\_D pin on the Master) is driven LOW, and the Master receiver is in Single Link (two-pixels per clock) mode.

The Master receiver is configured by pulling the M\_S pin to HIGH. When it is in Dual Link mode, the Master receiver is in one-pixel per clock mode outputting the EVEN data. The Master receiver's ODD data bus is tri-stated to allow the Slave receiver's EVEN data bus to be used as the ODD data bus. When it is in Single Link mode, the Master receiver is in two-pixels per clock mode outputting both the EVEN and ODD data. The Slave receiver's EVEN data bus is tri-stated to allow the Master receiver's ODD data bus to be used as the ODD data.

The DE output pin of the Master receiver is connected to the SYNC input pin of the Slave receiver. This is used for output synchronization between the Master receiver and Slave receiver. DE, HSYNC, VSYNC, and ODCK are all connected from the Master receiver.

#### Slave –

The Slave receiver is always configured for Dual Link (one pixel/clock) operation, by tying the S\_D pin to HIGH. The Slave receiver is never used in Single Link mode since the Master receiver is the primary receiver for Single Link Operation.

The Slave receiver is configured by tying the M\_S pin to LOW. The Slave receiver will always contain the ODD data bus in Dual Link operation. Therefore, it will never be in two-pixels per clock mode.

The SCDT output pin of the Slave receiver is connected to the S\_D input pin of the Master receiver to automatically configure the Master for either Single or Dual Link mode depending upon whether the Slave receiver is active or not.

The SYNC input pin of the Slave receiver is connected to the DE output pin of the Master receiver for synchronization.

Since DE, HSYNC, VSYNC, and ODCK are all taken from the Master receiver, these pins are not connected from the Slave receiver.

**Table 3. SiI 163B Dual Link Pin Configuration**

| S_D | PIXS/M_S | Master / Slave | Description                                                                                                                                                                                       |
|-----|----------|----------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 0   | 0        | Not Used       | <b>Single Link One Pixel/Clock Mode.</b> Not supported.                                                                                                                                           |
| 0   | 1        | Master         | <b>Single Link Two Pixel/Clock Mode.</b> This is the mode that the Master receiver will be in when in Single Link mode for pixel clock frequencies less than or equal to 165MHz.                  |
| 1   | 0        | Slave          | <b>Dual Link Slave (One Pixel/Clock) Mode.</b> This is the mode that the Slave receiver will always be in for pixel clock frequencies greater than 165MHz and less than 330MHz.                   |
| 1   | 1        | Master         | <b>Dual Link Master (One Pixel/Clock) Mode.</b> This is the mode that the Master receiver will be in when in Dual Link mode for pixel clock frequencies greater than 165MHz and less than 330MHz. |

## Dual Link Power Management

Power management with PD# and PDO# is slightly different in a Dual Link design than a Single Link. When the receivers are in dual-link mode (S\_D=1), then the connection from SCDT to PDO# is internal. A receiver which detects no activity at the TMDS inputs will deassert SCDT, which will then put that chip into power-down-output mode. This is the process which enables the slave receiver to tri-state its outputs whenever it stops receiving data.

The outputs may also be directly tri-stated by asserting the PDO# pin.

Receivers will also enter a low-power state when the differential TMDS clock stops. The receiver awakens when the clock resumes, at which point the receiver begins checking for active data. Active data will assert SCDT and put the chip back into full-power mode.

## Dual Link Mode Selection

### Single Link Mode –

In Single Link mode, the Slave receiver is not active. Its outputs are all tri-stated. The Slave receiver will detect that there is no signal coming from the transmitter and de-assert SCDT to LOW. The SCDT pin from the Slave receiver is connected to the Master receiver's S\_D pin. This will cause the S\_D pin of the Master receiver to be LOW that will cause the Master receiver to be in Single Link mode. Since the Master receiver is in Single Link mode, it will output two-pixels per clock. All the Data, both EVEN and ODD pixels, will be output from the Master receiver. The Slave receiver's EVEN Data bus is tri-stated to allow the Master receiver's ODD Data bus to be used as the ODD Data.

### Dual Link Mode –

In Dual Link mode, the Slave receiver is active. The Slave receiver will detect that there are valid signals coming from the transmitter and assert SCDT to HIGH. This will cause the S\_D pin of the Master receiver to be HIGH that will cause the Master receiver to be in Dual Link mode. This will also cause the Master receiver to tri-state its Odd Data bus to allow the Slave receiver's EVEN Data bus to be used as the ODD Data. The Master receiver will output the EVEN Data. When there are no sync signals coming from the transmitter, both the Slave and Master receiver's outputs are tri-stated automatically.

The STAG\_OUT pin of the Slave receiver is not used in one-pixel per clock mode, so this takes on a different meaning in Dual Link mode. It becomes SYNC input pin. This pin is used for synchronization between the Master and Slave receivers. The DE output pin from the Master receiver is connected to the SYNC input pin of the Slave receiver.

Dual Link Timing Diagrams

Below in Figure 12 is an example of the output timing diagram of the Master receiver. When the Slave receiver's SCDT signal is LOW, the Slave receiver is inactive and has tri-stated all its data outputs. This is because the system is sending data with a pixel clock of less than or equal to 165. The DVI link uses the Master receiver only. There are no signals being sent to the Slave receiver from the system. The Master receiver is in Single Link 2-pixel/clock mode and outputs the pixel data, both EVEN and ODD pixels.

When the Slave receiver's SCDT signal goes HIGH, the system is sending data with a pixel clock greater than 165 MHz and less than 330 MHz. The system is sending the EVEN pixel to the Master receiver and the ODD pixel to the Slave receiver. The Slave receiver is receiving signals from the system and has asserted its SCDT signal to the Master receiver. This puts the Master receiver in Dual Link 1-pixel/clock mode. The Slave receiver outputs the ODD pixel data. The Master receiver outputs the EVEN pixel data. The Master receiver has tri-stated its ODD pixel bus to allow the Slave receiver to send ODD pixel data.

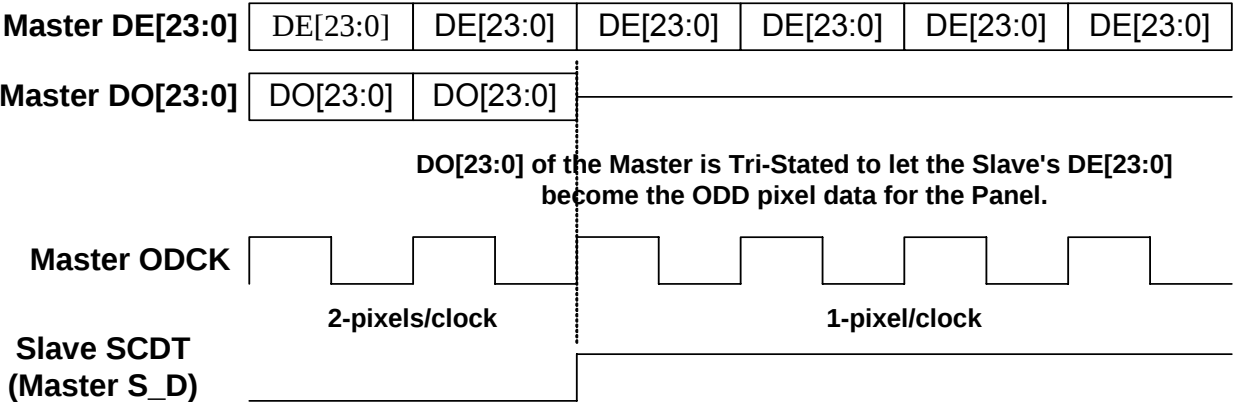


Figure 12. Timing Diagram of Master's Output

Figure 13 is an example of the output timing diagram of the Slave receiver. When the Slave receiver's SCDT signal is LOW, the Slave receiver is inactive and has tri-stated all its outputs. This is because the system is sending data with a pixel clock of less than or equal to 165 MHz on the link connected to the Master receiver only. There are no signals being sent to the Slave receiver from the system.

When the Slave receiver's SCDT signal goes HIGH, the system is sending data with a pixel clock greater than 165 MHz and less than 330 MHz. The system is sending the EVEN pixel to the Master receiver and the ODD pixel to the Slave receiver. The Slave receiver is receiving signals from the system and has asserted its SCDT signal to the Master receiver. This puts the Master receiver in Dual Link 1-pixel/clock mode. The Slave receiver is outputting the ODD pixel data on its EVEN pixel bus. The Master receiver outputs the EVEN pixels. The Master receiver has tri-stated its ODD pixel bus to allow the Slave receiver to send ODD pixel data.

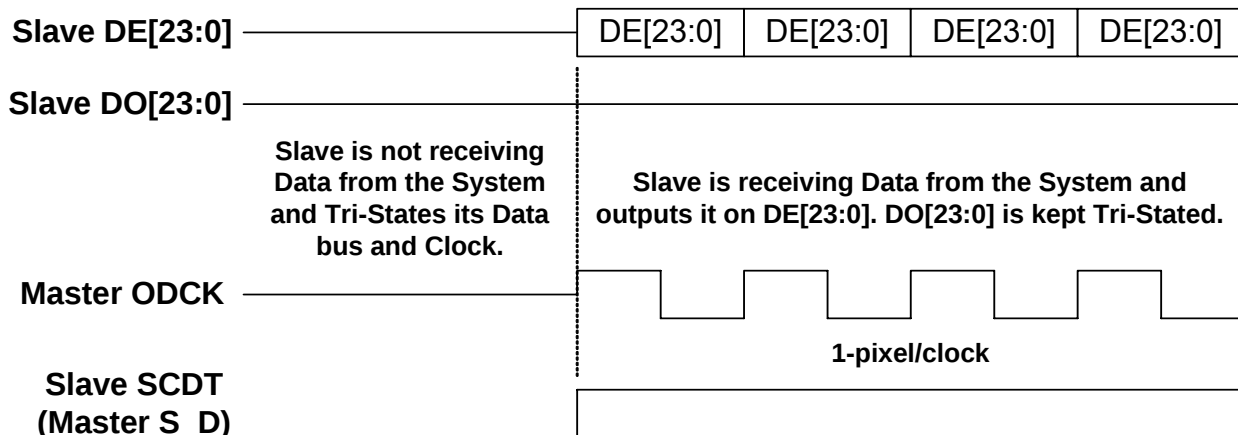


Figure 13. Timing Diagram of Slave's Output

Figure 14 is an example of the data that is driven out by the two receivers. All the control signals, including ODCK, are sent by the Master receiver.

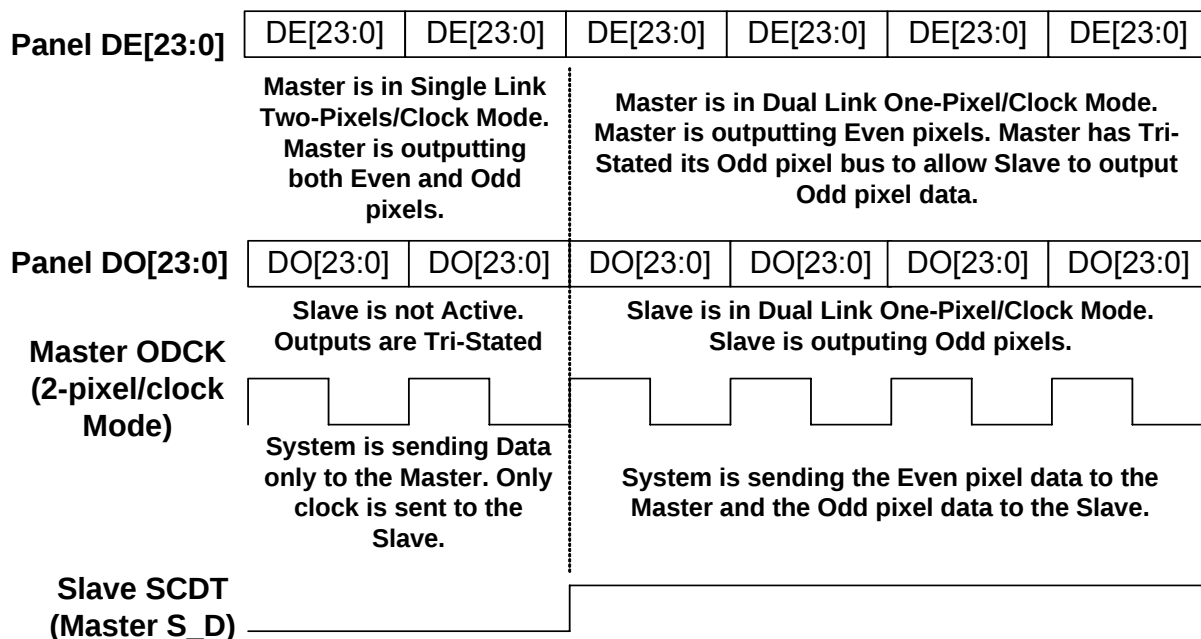


Figure 14. Single/Dual Link Timing Diagram

**Table 4. DVI-D Connector to SiI 163B for Dual Link Application Pin Connection**

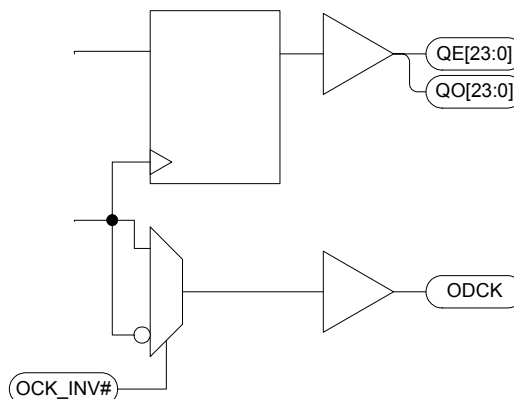
| DVI-D Connector |                     | SiI 163B - Master |                 | SiI 163B - Slave |                |
|-----------------|---------------------|-------------------|-----------------|------------------|----------------|
| Pin #           | Signal              | Pin #             | Pin Name        | Pin #            | Pin Name       |
| 1               | TMDS Data2-         | 81                | Rx2- for Master |                  |                |
| 2               | TMDS Data2+         | 80                | Rx2+ for Master |                  |                |
| 3               | TMDS Data2/4 Shield |                   |                 |                  |                |
| 4               | TMDS Data4-         |                   |                 | 86               | Rx1- for Slave |
| 5               | TMDS Data4+         |                   |                 | 85               | Rx1+ for Slave |
| 6               | DDC Clock           |                   |                 |                  |                |
| 7               | DDC Data            |                   |                 |                  |                |
| 8               | NC                  |                   |                 |                  |                |
| 9               | TMDS Data1-         | 86                | Rx1- for Master |                  |                |
| 10              | TMDS Data1+         | 85                | Rx1+ for Master |                  |                |
| 11              | TMDS Data1/3 Shield |                   |                 |                  |                |
| 12              | TMDS Data3-         |                   |                 | 91               | Rx0- for Slave |
| 13              | TMDS Data3+         |                   |                 | 90               | Rx0+ for Slave |
| 14              | +5V Power           |                   |                 |                  |                |
| 15              | Ground              |                   |                 |                  |                |
| 16              | Hot Plug Detect     |                   |                 |                  |                |
| 17              | TMDS Data0-         | 91                | Rx0- for Master |                  |                |
| 18              | TMDS Data0+         | 90                | Rx0+ for Master |                  |                |
| 19              | TMDS Data0/5 Shield |                   |                 |                  |                |
| 20              | TMDS Data5-         |                   |                 | 81               | Rx2- for Slave |
| 21              | TMDS Data5+         |                   |                 | 80               | Rx2+ for Slave |
| 22              | TMDS Clock Shield   |                   |                 |                  |                |
| 23              | TMDS Clock+         | 93                | RxC+ for Master | 93               | RxC+ for Slave |
| 24              | TMDS Clock-         | 94                | RxC- for Master | 94               | RxC- for Slave |

## Clock Detect Function

The SiI 163B includes a new power saving feature: power down with clock detect circuit. The SiI 163B will go into a low power mode when there is no video clock coming from the transmitter. In this mode, the entire chip is powered down except the clock detect circuitry. During this mode, digital I/O are set to a high impedance (tri-state) mode. A weak internal pull-down device brings each output to ground. The device power down and wake-up times are shown in Figure 6 and Figure 7.

## OCK\_INV# Function

OCK\_INV# affects only the phase of the clock output as indicated in Figure 15. OCK\_INV# does not change the timing for the internal data latching. This timing is shown in Figure 5.


**Figure 15. Block Diagram for OCK\_INV#**

## TFT Panel Data Mapping

Table 5 summarizes the output data mapping in one pixel per clock mode for the SiI 163B. This output data mapping is dependent upon the PanelLink transmitters having the exact same type of input data mappings.

Table 6 summarizes the output data mapping in two pixel per clock mode. More detailed mapping information is found on the following pages. Refer to application note SiI-AN-0007 for DSTN applications.

Note that the choice of one pixel/clock versus two pixel/clock on the transmitter side has no effect on the choice of one pixel/clock versus two pixel/clock on the receiver side. The data is always sent across the link at the pixel clock rate. Therefore, designers using PanelLink receivers do not need to know how the transmitter has taken in pixel data on the transmitter input pins.

**Table 5. One Pixel/Clock Mode Data Mapping**

| DATA       | SiI 163B             |           |
|------------|----------------------|-----------|
|            | 1-Pixel/Clock Output |           |
|            | 18bpp                | 24bpp     |
| BLUE[7:0]  | QE[7:2]              | QE[7:0]   |
| GREEN[7:0] | QE[15:10]            | QE[15:8]  |
| RED[7:0]   | QE[23:18]            | QE[23:16] |

**Table 6. Two Pixel/Clock Mode Data Mapping**

| DATA           | SiI 163B             |           |
|----------------|----------------------|-----------|
|                | 2-Pixel/Clock Output |           |
|                | 18bpp                | 24bpp     |
| BLUE[7:0] – 0  | QE[7:2]              | QE[7:0]   |
| GREEN[7:0] – 0 | QE[15:10]            | QE[15:8]  |
| RED[7:0] – 0   | QE[23:18]            | QE[23:16] |
| BLUE[7:0] – 1  | QO[7:2]              | QO[7:0]   |
| GREEN[7:0] – 1 | QO[15:10]            | QO[15:8]  |
| RED[7:0] – 1   | QO[23:18]            | QO[23:16] |

**Note:** SiI143B, SiI151B, SiI153B and SiI 161B all have the same pinout. The pin assignments shown in the following tables should also be used for these other receivers.

**Table 7. One Pixel/Clock Input/Output TFT Mode – VESA P&D and FPD1-2™ Compliant**

| TFT VGA Output |           | Tx Input Data |       | Rx Output Data |       | TFT Panel Input |           |
|----------------|-----------|---------------|-------|----------------|-------|-----------------|-----------|
| 24-bpp         | 18-bpp    | 160           | 164   | 163B           | 141B  | 24-bpp          | 18-bpp    |
| B0             |           | DIE0          | D0    | QE0            | Q0    | B0              |           |
| B1             |           | DIE1          | D1    | QE1            | Q1    | B1              |           |
| B2             | B0        | DIE2          | D2    | QE2            | Q2    | B2              | B0        |
| B3             | B1        | DIE3          | D3    | QE3            | Q3    | B3              | B1        |
| B4             | B2        | DIE4          | D4    | QE4            | Q4    | B4              | B2        |
| B5             | B3        | DIE5          | D5    | QE5            | Q5    | B5              | B3        |
| B6             | B4        | DIE6          | D6    | QE6            | Q6    | B6              | B4        |
| B7             | B5        | DIE7          | D7    | QE7            | Q7    | B7              | B5        |
| G0             |           | DIE8          | D8    | QE8            | Q8    | G0              |           |
| G1             |           | DIE9          | D9    | QE9            | Q9    | G1              |           |
| G2             | G0        | DIE10         | D10   | QE10           | Q10   | G2              | G0        |
| G3             | G1        | DIE11         | D11   | QE11           | Q11   | G3              | G1        |
| G4             | G2        | DIE12         | D12   | QE12           | Q12   | G4              | G2        |
| G5             | G3        | DIE13         | D13   | QE13           | Q13   | G5              | G3        |
| G6             | G4        | DIE14         | D14   | QE14           | Q14   | G6              | G4        |
| G7             | G5        | DIE15         | D15   | QE15           | Q15   | G7              | G5        |
| R0             |           | DIE16         | D16   | QE16           | Q16   | R0              |           |
| R1             |           | DIE17         | D17   | QE17           | Q17   | R1              |           |
| R2             | R0        | DIE18         | D18   | QE18           | Q18   | R2              | R0        |
| R3             | R1        | DIE19         | D19   | QE19           | Q19   | R3              | R1        |
| R4             | R2        | DIE20         | D20   | QE20           | Q20   | R4              | R2        |
| R5             | R3        | DIE21         | D21   | QE21           | Q21   | R5              | R3        |
| R6             | R4        | DIE22         | D22   | QE22           | Q22   | R6              | R4        |
| R7             | R5        | DIE23         | D23   | QE23           | Q23   | R7              | R5        |
| Shift CLK      | Shift CLK | IDCK          | IDCK  | ODCK           | ODCK  | Shift CLK       | Shift CLK |
| VSYNC          | VSYNC     | VSYNC         | VSYNC | VSYNC          | VSYNC | VSYNC           | VSYNC     |
| HSYNC          | HSYNC     | HSYNC         | HSYNC | HSYNC          | HSYNC | HSYNC           | HSYNC     |
| DE             | DE        | DE            | DE    | DE             | DE    | DE              | DE        |

For 18-bit mode, the Flat Panel Graphics Controller interfaces to the Transmitter exactly the same as in the 24-bit mode; however, 6 bits per channel (color) are used instead of 8. It is recommended that unused data bits be tied low. As can be seen from the above table, the data mapping for less than 24-bit per pixel interfaces are MSB justified. The data is sent during active display time while the control signals are sent during blank time. Note that the three data channels (CH0, CH1, CH2) are mapped to Blue, Green and Red data respectively.

**Table 8. Two Pixels/Clock Input/Output TFT Mode**

| TFT VGA Output<br>24-bpp | Output<br>18-bpp | Tx Input Data<br>160 | Rx Output Data<br>163B | TFT Panel Input<br>24-bpp | 18-bpp    |
|--------------------------|------------------|----------------------|------------------------|---------------------------|-----------|
| B0 – 0                   |                  | DIE0                 | QE0                    | B0 – 0                    |           |
| B1 – 0                   |                  | DIE1                 | QE1                    | B1 – 0                    |           |
| B2 – 0                   | B0 – 0           | DIE2                 | QE2                    | B2 – 0                    | B0 – 0    |
| B3 – 0                   | B1 – 0           | DIE3                 | QE3                    | B3 – 0                    | B1 – 0    |
| B4 – 0                   | B2 – 0           | DIE4                 | QE4                    | B4 – 0                    | B2 – 0    |
| B5 – 0                   | B3 – 0           | DIE5                 | QE5                    | B5 – 0                    | B3 – 0    |
| B6 – 0                   | B4 – 0           | DIE6                 | QE6                    | B6 – 0                    | B4 – 0    |
| B7 – 0                   | B5 – 0           | DIE7                 | QE7                    | B7 – 0                    | B5 – 0    |
| G0 – 0                   |                  | DIE8                 | QE8                    | G0 – 0                    |           |
| G1 – 0                   |                  | DIE9                 | QE9                    | G1 – 0                    |           |
| G2 – 0                   | G0 – 0           | DIE10                | QE10                   | G2 – 0                    | G0 – 0    |
| G3 – 0                   | G1 – 0           | DIE11                | QE11                   | G3 – 0                    | G1 – 0    |
| G4 – 0                   | G2 – 0           | DIE12                | QE12                   | G4 – 0                    | G2 – 0    |
| G5 – 0                   | G3 – 0           | DIE13                | QE13                   | G5 – 0                    | G3 – 0    |
| G6 – 0                   | G4 – 0           | DIE14                | QE14                   | G6 – 0                    | G4 – 0    |
| G7 – 0                   | G5 – 0           | DIE15                | QE15                   | G7 – 0                    | G5 – 0    |
| R0 – 0                   |                  | DIE16                | QE16                   | R0 – 0                    |           |
| R1 – 0                   |                  | DIE17                | QE17                   | R1 – 0                    |           |
| R2 – 0                   | R0 – 0           | DIE18                | QE18                   | R2 – 0                    | R0 – 0    |
| R3 – 0                   | R1 – 0           | DIE19                | QE19                   | R3 – 0                    | R1 – 0    |
| R4 – 0                   | R2 – 0           | DIE20                | QE20                   | R4 – 0                    | R2 – 0    |
| R5 – 0                   | R3 – 0           | DIE21                | QE21                   | R5 – 0                    | R3 – 0    |
| R6 – 0                   | R4 – 0           | DIE22                | QE22                   | R6 – 0                    | R4 – 0    |
| R7 – 0                   | R5 – 0           | DIE23                | QE23                   | R7 – 0                    | R5 – 0    |
| B0 – 1                   |                  | DIO0                 | QO0                    | B0 – 1                    |           |
| B1 – 1                   |                  | DIO1                 | QO1                    | B1 – 1                    |           |
| B2 – 1                   | B0 – 1           | DIO2                 | QO2                    | B2 – 1                    | B0 – 1    |
| B3 – 1                   | B1 – 1           | DIO3                 | QO3                    | B3 – 1                    | B1 – 1    |
| B4 – 1                   | B2 – 1           | DIO4                 | QO4                    | B4 – 1                    | B2 – 1    |
| B5 – 1                   | B3 – 1           | DIO5                 | QO5                    | B5 – 1                    | B3 – 1    |
| B6 – 1                   | B4 – 1           | DIO6                 | QO6                    | B6 – 1                    | B4 – 1    |
| B7 – 1                   | B5 – 1           | DIO7                 | QO7                    | B7 – 1                    | B5 – 1    |
| G0 – 1                   |                  | DIO8                 | QO8                    | G0 – 1                    |           |
| G1 – 1                   |                  | DIO9                 | QO9                    | G1 – 1                    |           |
| G2 – 1                   | G0 – 1           | DIO10                | QO10                   | G2 – 1                    | G0 – 1    |
| G3 – 1                   | G1 – 1           | DIO11                | QO11                   | G3 – 1                    | G1 – 1    |
| G4 – 1                   | G2 – 1           | DIO12                | QO12                   | G4 – 1                    | G2 – 1    |
| G5 – 1                   | G3 – 1           | DIO13                | QO13                   | G5 – 1                    | G3 – 1    |
| G6 – 1                   | G4 – 1           | DIO14                | QO14                   | G6 – 1                    | G4 – 1    |
| G7 – 1                   | G5 – 1           | DIO15                | QO15                   | G7 – 1                    | G5 – 1    |
| R0 – 1                   |                  | DIO16                | QO16                   | R0 – 1                    |           |
| R1 – 1                   |                  | DIO17                | QO17                   | R1 – 1                    |           |
| R2 – 1                   | R0 – 1           | DIO18                | QO18                   | R2 – 1                    | R0 – 1    |
| R3 – 1                   | R1 – 1           | DIO19                | QO19                   | R3 – 1                    | R1 – 1    |
| R4 – 1                   | R2 – 1           | DIO20                | QO20                   | R4 – 1                    | R2 – 1    |
| R5 – 1                   | R3 – 1           | DIO21                | QO21                   | R5 – 1                    | R3 – 1    |
| R6 – 1                   | R4 – 1           | DIO22                | QO22                   | R6 – 1                    | R4 – 1    |
| R7 – 1                   | R5 – 1           | DIO23                | QO23                   | R7 – 1                    | R5 – 1    |
| ShiftClk/2               | ShiftClk/2       | IDCK                 | ODCK                   | Shift CLK                 | Shift CLK |
| VSYNC                    | VSYNC            | VSYNC                | VSYNC                  | VSYNC                     | VSYNC     |
| HSYNC                    | HSYNC            | HSYNC                | HSYNC                  | HSYNC                     | HSYNC     |
| DE                       | DE               | DE                   | DE                     | DE                        | DE        |

**Table 9. 24-bit One Pixel/Clock Input with 24-bit Two Pixels/Clock Output TFT Mode**

| TFT VGA Output<br>24-bpp | Tx Input Data |       | Rx Output Data | TFT Panel Input |
|--------------------------|---------------|-------|----------------|-----------------|
|                          | 160           | 164   | 163B           | 24-bpp          |
| B0                       | DIE0          | D0    | QE0            | B0 – 0          |
| B1                       | DIE1          | D1    | QE1            | B1 – 0          |
| B2                       | DIE2          | D2    | QE2            | B2 – 0          |
| B3                       | DIE3          | D3    | QE3            | B3 – 0          |
| B4                       | DIE4          | D4    | QE4            | B4 – 0          |
| B5                       | DIE5          | D5    | QE5            | B5 – 0          |
| B6                       | DIE6          | D6    | QE6            | B6 – 0          |
| B7                       | DIE7          | D7    | QE7            | B7 – 0          |
| G0                       | DIE8          | D8    | QE8            | G0 – 0          |
| G1                       | DIE9          | D9    | QE9            | G1 – 0          |
| G2                       | DIE10         | D10   | QE10           | G2 – 0          |
| G3                       | DIE11         | D11   | QE11           | G3 – 0          |
| G4                       | DIE12         | D12   | QE12           | G4 – 0          |
| G5                       | DIE13         | D13   | QE13           | G5 – 0          |
| G6                       | DIE14         | D14   | QE14           | G6 – 0          |
| G7                       | DIE15         | D15   | QE15           | G7 – 0          |
| R0                       | DIE16         | D16   | QE16           | R0 – 0          |
| R1                       | DIE17         | D17   | QE17           | R1 – 0          |
| R2                       | DIE18         | D18   | QE18           | R2 – 0          |
| R3                       | DIE19         | D19   | QE19           | R3 – 0          |
| R4                       | DIE20         | D20   | QE20           | R4 – 0          |
| R5                       | DIE21         | D21   | QE21           | R5 – 0          |
| R6                       | DIE22         | D22   | QE22           | R6 – 0          |
| R7                       | DIE23         | D23   | QE23           | R7 – 0          |
|                          |               |       | QO0            | B0 – 1          |
|                          |               |       | QO1            | B1 – 1          |
|                          |               |       | QO2            | B2 – 1          |
|                          |               |       | QO3            | B3 – 1          |
|                          |               |       | QO4            | B4 – 1          |
|                          |               |       | QO5            | B5 – 1          |
|                          |               |       | QO6            | B6 – 1          |
|                          |               |       | QO7            | B7 – 1          |
|                          |               |       | QO8            | G0 – 1          |
|                          |               |       | QO9            | G1 – 1          |
|                          |               |       | QO10           | G2 – 1          |
|                          |               |       | QO11           | G3 – 1          |
|                          |               |       | QO12           | G4 – 1          |
|                          |               |       | QO13           | G5 – 1          |
|                          |               |       | QO14           | G6 – 1          |
|                          |               |       | QO15           | G7 – 1          |
|                          |               |       | QO16           | R0 – 1          |
|                          |               |       | QO17           | R1 – 1          |
|                          |               |       | QO18           | R2 – 1          |
|                          |               |       | QO19           | R3 – 1          |
|                          |               |       | QO20           | R4 – 1          |
|                          |               |       | QO21           | R5 – 1          |
|                          |               |       | QO22           | R6 – 1          |
|                          |               |       | QO23           | R7 – 1          |
| Shift CLK                | IDCK          | IDCK  | ODCK           | Shift CLK/2     |
| VSYNC                    | VSYNC         | VSYNC | VSYNC          | VSYNC           |
| HSYNC                    | HSYNC         | HSYNC | HSYNC          | HSYNC           |
| DE                       | DE            | DE    | DE             | DE              |

**Table 10. 18-bit One Pixel/Clock Input with 18-bit Two Pixels/Clock Output TFT Mode**

| TFT VGA Output<br>18-bpp | Tx Input Data |      | Tx Output Data |             | TFT Panel Input<br>18-bpp |
|--------------------------|---------------|------|----------------|-------------|---------------------------|
|                          | 160           | 164  | 163B           | 141B        |                           |
|                          | DIE0          | D0   | QE0            |             |                           |
|                          | DIE1          | D1   | QE1            |             |                           |
| B0                       | DIE2          | D2   | QE2            | Q0          | B0 – 0                    |
| B1                       | DIE3          | D3   | QE3            | Q1          | B1 – 0                    |
| B2                       | DIE4          | D4   | QE4            | Q2          | B2 – 0                    |
| B3                       | DIE5          | D5   | QE5            | Q3          | B3 – 0                    |
| B4                       | DIE6          | D6   | QE6            | Q4          | B4 – 0                    |
| B5                       | DIE7          | D7   | QE7            | Q5          | B5 – 0                    |
|                          | DIE8          | D8   | QE8            |             |                           |
|                          | DIE9          | D9   | QE9            |             |                           |
| G0                       | DIE10         | D10  | QE10           | Q6          | G0 – 0                    |
| G1                       | DIE11         | D11  | QE11           | Q7          | G1 – 0                    |
| G2                       | DIE12         | D12  | QE12           | Q8          | G2 – 0                    |
| G3                       | DIE13         | D13  | QE13           | Q9          | G3 – 0                    |
| G4                       | DIE14         | D14  | QE14           | Q10         | G4 – 0                    |
| G5                       | DIE15         | D15  | QE15           | Q11         | G5 – 0                    |
|                          | DIE16         | D16  | QE16           |             |                           |
|                          | DIE17         | D17  | QE17           |             |                           |
| R0                       | DIE18         | D18  | QE18           | Q12         | R0 – 0                    |
| R1                       | DIE19         | D19  | QE19           | Q13         | R1 – 0                    |
| R2                       | DIE20         | D20  | QE20           | Q14         | R2 – 0                    |
| R3                       | DIE21         | D21  | QE21           | Q15         | R3 – 0                    |
| R4                       | DIE22         | D22  | QE22           | Q16         | R4 – 0                    |
| R5                       | DIE23         | D23  | QE23           | Q17         | R5 – 0                    |
|                          |               |      | Q00            |             |                           |
|                          |               |      | Q01            |             |                           |
|                          |               |      | Q02            | Q18         | B0 – 1                    |
|                          |               |      | Q03            | Q19         | B1 – 1                    |
|                          |               |      | Q04            | Q20         | B2 – 1                    |
|                          |               |      | Q05            | Q21         | B3 – 1                    |
|                          |               |      | Q06            | Q22         | B4 – 1                    |
|                          |               |      | Q07            | Q23         | B5 – 1                    |
|                          |               |      | Q08            |             |                           |
|                          |               |      | Q09            |             |                           |
|                          |               |      | Q010           | Q24         | G0 – 1                    |
|                          |               |      | Q011           | Q25         | G1 – 1                    |
|                          |               |      | Q012           | Q26         | G2 – 1                    |
|                          |               |      | Q013           | Q27         | G3 – 1                    |
|                          |               |      | Q014           | Q28         | G4 – 1                    |
|                          |               |      | Q015           | Q29         | G5 – 1                    |
|                          |               |      | Q016           |             |                           |
|                          |               |      | Q017           |             |                           |
|                          |               |      | Q018           | Q30         | R0 – 1                    |
|                          |               |      | Q019           | Q31         | R1 – 1                    |
|                          |               |      | Q020           | Q32         | R2 – 1                    |
|                          |               |      | Q021           | Q33         | R3 – 1                    |
|                          |               |      | Q022           | Q34         | R4 – 1                    |
|                          |               |      | Q023           | Q35         | R5 – 1                    |
| Shift CLK                | IDCK          | IDCK | ODCK           | Shift CLK/2 | Shift CLK/2               |
| VSNC                     | VSNC          | VSNC | VSNC           | VSNC        | VSNC                      |
| HSNC                     | HSNC          | HSNC | HSNC           | HSNC        | HSNC                      |
| DE                       | DE            | DE   | DE             | DE          | DE                        |

**Table 11. Two Pixels/Clock Input with One Pixel/Clock Output TFT Mode**

| TFT VGA Output |            | Tx Input Data | Rx Output Data |       | TFT Panel Input |          |
|----------------|------------|---------------|----------------|-------|-----------------|----------|
| 24-bpp         | 18-bpp     | 160           | 163B           | 141B  | 24-bpp          | 18-bpp   |
| B0 – 0         |            | DIE0          | QE0            | Q0    | B0              |          |
| B1 – 0         |            | DIE1          | QE1            | Q1    | B1              |          |
| B2 – 0         | B0 – 0     | DIE2          | QE2            | Q2    | B2              | B0       |
| B3 – 0         | B1 – 0     | DIE3          | QE3            | Q3    | B3              | B1       |
| B4 – 0         | B2 – 0     | DIE4          | QE4            | Q4    | B4              | B2       |
| B5 – 0         | B3 – 0     | DIE5          | QE5            | Q5    | B5              | B3       |
| B6 – 0         | B4 – 0     | DIE6          | QE6            | Q6    | B6              | B4       |
| B7 – 0         | B5 – 0     | DIE7          | QE7            | Q7    | B7              | B5       |
| G0 – 0         |            | DIE8          | QE8            | Q8    | G0              |          |
| G1 – 0         |            | DIE9          | QE9            | Q9    | G1              |          |
| G2 – 0         | G0 – 0     | DIE10         | QE10           | Q10   | G2              | G0       |
| G3 – 0         | G1 – 0     | DIE11         | QE11           | Q11   | G3              | G1       |
| G4 – 0         | G2 – 0     | DIE12         | QE12           | Q12   | G4              | G2       |
| G5 – 0         | G3 – 0     | DIE13         | QE13           | Q13   | G5              | G3       |
| G6 – 0         | G4 – 0     | DIE14         | QE14           | Q14   | G6              | G4       |
| G7 – 0         | G5 – 0     | DIE15         | QE15           | Q15   | G7              | G5       |
| R0 – 0         |            | DIE16         | QE16           | Q16   | R0              |          |
| R1 – 0         |            | DIE17         | QE17           | Q17   | R1              |          |
| R2 – 0         | R0 – 0     | DIE18         | QE18           | Q18   | R2              | R0       |
| R3 – 0         | R1 – 0     | DIE19         | QE19           | Q19   | R3              | R1       |
| R4 – 0         | R2 – 0     | DIE20         | QE20           | Q20   | R4              | R2       |
| R5 – 0         | R3 – 0     | DIE21         | QE21           | Q21   | R5              | R3       |
| R6 – 0         | R4 – 0     | DIE22         | QE22           | Q22   | R6              | R4       |
| R7 – 0         | R5 – 0     | DIE23         | QE23           | Q23   | R7              | R5       |
| B0 – 1         |            | DIO0          |                |       |                 |          |
| B1 – 1         |            | DIO1          |                |       |                 |          |
| B2 – 1         | B0 – 1     | DIO2          |                |       |                 |          |
| B3 – 1         | B1 – 1     | DIO3          |                |       |                 |          |
| B4 – 1         | B2 – 1     | DIO4          |                |       |                 |          |
| B5 – 1         | B3 – 1     | DIO5          |                |       |                 |          |
| B6 – 1         | B4 – 1     | DIO6          |                |       |                 |          |
| B7 – 1         | B5 – 1     | DIO7          |                |       |                 |          |
| G0 – 1         |            | DIO8          |                |       |                 |          |
| G1 – 1         |            | DIO9          |                |       |                 |          |
| G2 – 1         | G0 – 1     | DIO10         |                |       |                 |          |
| G3 – 1         | G1 – 1     | DIO11         |                |       |                 |          |
| G4 – 1         | G2 – 1     | DIO12         |                |       |                 |          |
| G5 – 1         | G3 – 1     | DIO13         |                |       |                 |          |
| G6 – 1         | G4 – 1     | DIO14         |                |       |                 |          |
| G7 – 1         | G5 – 1     | DIO15         |                |       |                 |          |
| R0 – 1         |            | DIO16         |                |       |                 |          |
| R1 – 1         |            | DIO17         |                |       |                 |          |
| R2 – 1         | R0 – 1     | DIO18         |                |       |                 |          |
| R3 – 1         | R1 – 1     | DIO19         |                |       |                 |          |
| R4 – 1         | R2 – 1     | DIO20         |                |       |                 |          |
| R5 – 1         | R3 – 1     | DIO21         |                |       |                 |          |
| R6 – 1         | R4 – 1     | DIO22         |                |       |                 |          |
| R7 – 1         | R5 – 1     | DIO23         |                |       |                 |          |
| ShiftClk/2     | ShiftClk/2 | IDCK          | ODCK           | ODCK  | ShiftClk        | ShiftClk |
| VSYNC          | VSYNC      | VSYNC         | VSYNC          | VSYNC | VSYNC           | VSYNC    |
| HSYNC          | HSYNC      | HSYNC         | HSYNC          | HSYNC | HSYNC           | HSYNC    |
| DE             | DE         | DE            | DE             | DE    | DE              | DE       |

**Table 12. Output Clock Configuration by Typical Application**

| DF0 | PIX | OCK_INV# | PANEL           | ODCK (frequency/data latch edge/mode) |
|-----|-----|----------|-----------------|---------------------------------------|
| 0   | 0   | 0        | TFT/16-bit DSTN | divide by 1 / negative / free running |
| 0   | 0   | 1        | TFT/16-bit DSTN | divide by 1 / positive / free running |
| 0   | 1   | 0        | TFT             | divide by 2 / negative / free running |
| 0   | 1   | 1        | TFT             | divide by 2 / positive / free running |
| 1   | 0   | 0        | 24-bit DSTN     | divide by 1 / negative / blanked low  |
| 1   | 0   | 1        | <b>NONE</b>     | divide by 1 / negative / blanked high |
| 1   | 1   | 0        | 24-bit DSTN     | divide by 2 / negative / blanked low  |
| 1   | 1   | 1        | 24-bit DSTN     | divide by 4 / negative / blanked low  |

**Note:** DF0 is a signal available only on the SiI141B receiver. DSTN panels may be supported with the SiI 163B by running the extra blanked clock through an unused data pin. This works only at one pixel per clock mode, and only when the 24 data bits are not already used for pixel data. Such a solution also requires that the transmitter board design input the shift clock (the blanked clock for DSTN) into the same unused data pin. By using the SiI141B, DSTN panels may be driven without requiring any special connections on the transmitter side.

## Design Recommendations

The following sections describe recommendations for robust board design with this PanelLink receiver. Designers should include provision for these circuits in their design, and adjust the specific passive component values according to the characterization results.

### Differences Between SiI 161A and SiI 163B

While the SiI 163B is pin to pin compatible with the SiI 161A, there are minor differences in functions and suggested external component value. When designing the SiI 163B into an existing design, note that the recommended external resistor (EXT\_RES) value has changed from 560 ohms to 390 ohms to match the impedance of a 50 ohm cable.

Table 13 lists the differences between SiI 161A and SiI 163B. Table 14 lists SiI 161B to SiI 163B differences.

**Table 13. SiI 161A vs. SiI 163B Pin Differences**

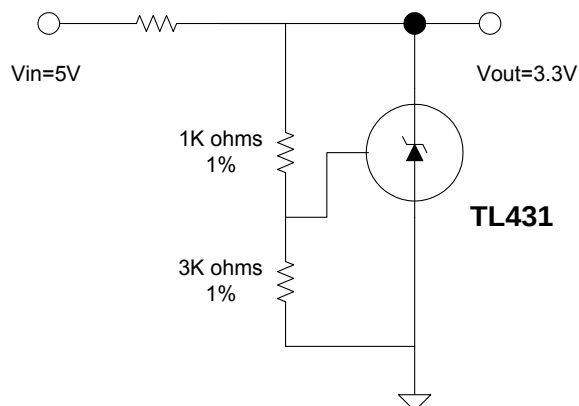
| Pin/Function                           | SiI 161A                                                                                                                                           | SiI 163B                                                                                                                                                                                                  |
|----------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| EXT_RES Resistor Value                 | 560 ohm                                                                                                                                            | 390 ohm                                                                                                                                                                                                   |
| SCDT                                   | When PDO# is asserted, a pull-up resistor is needed on SCDT to assure high-level.                                                                  | SCDT continues to drive high or low when PDO# is asserted. No need for pull-up.                                                                                                                           |
| HSYNC, VSYNC, CTL[1..3]                | Dejitter circuit adds one pixel clock time to time from DE fall to first edge of these signals. This affects front-porch time for HSYNC and VSYNC. | Dejitter circuit is always disabled.                                                                                                                                                                      |
| Improved Output Drive Strength         | Refer to SiI 161A Data Sheet for specifics.                                                                                                        | Output drive strength improved for these signals. Refer to DC Specifications on page 4. This improves output waveforms when driving multiple loads. Some designs may be able to change from ST=1 to ST=0. |
| Clock Detect for Lower Standby Power.  | Receiver powers down when PDO# is asserted. SCDT asserts only when the chip detects the lack of DE pulses.                                         | Receiver detects when the differential input clock has stopped and powers down the internals of the chip. Refer to I <sub>CLKI</sub> in DC Specifications on page 4.                                      |
| PDO# Low-Power Mode Improved           | PDO# assertion powers down most of the chip.                                                                                                       | Improved design powers down more active circuitry, resulting in lower power when PDO# is asserted.                                                                                                        |
| Differential Input Capacitance Reduced |                                                                                                                                                    | Improved DVI signal reception from SiI 161A .                                                                                                                                                             |
| PD#, PDO#, STAG_OUT#, OCK_INV#         | Pins were named: PD, PDO, STAG_OUT and OCK_INV.                                                                                                    | No functional change was made. Names were changed to clarify their "active low" sense.                                                                                                                    |

**Table 14. SiI 161B vs. SiI 163B Pin Differences**

| Pin/Function                 | SiI 161B                                                                                                                                                                                               | SiI 163B                                                                                                                  |
|------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------|
| PDO# Low-Power Mode Improved | PDO# assertion powers down most of the chip.                                                                                                                                                           | In dual-link mode, the SCDT to PDO# connection is also internal and automatic. See Dual Link Power Management on page 16. |
| HSYNC, VSYNC, CTL[1:3]       | Dejitter circuit improved over SiI 161A. The DE-low to first-edge time for these signals is identical to the timing input to the transmitter. Dejitter circuit may be enabled or disabled using a pin. | Dejitter circuit is always disabled. There is no package pin to control this feature.                                     |

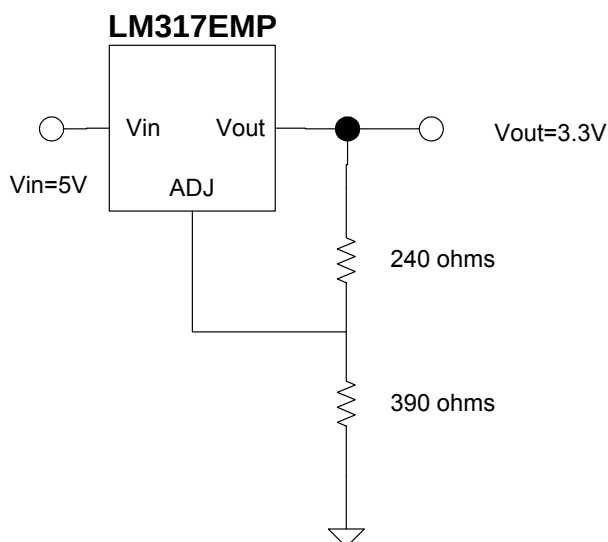
## Voltage Ripple Regulation

The power supply to VCC pins is very important to the proper operation of the receiver chips. Two examples of regulators are shown in Figure 16 and Figure 17.



**Figure 16. Voltage Regulation using TL431**

Decoupling and bypass capacitors are also involved with power supply connections, as described in detail in Figure 19.



**Figure 17. Voltage Regulation using LM317**

## Decoupling Capacitors

Designers should include decoupling and bypass capacitors at each power pin in the layout. These are shown schematically in Figure 19. Place these components as closely as possible to the PanelLink device pins, and avoid routing through vias if possible, as shown in Figure 18, which is representative of the various types of power pins on the receiver.

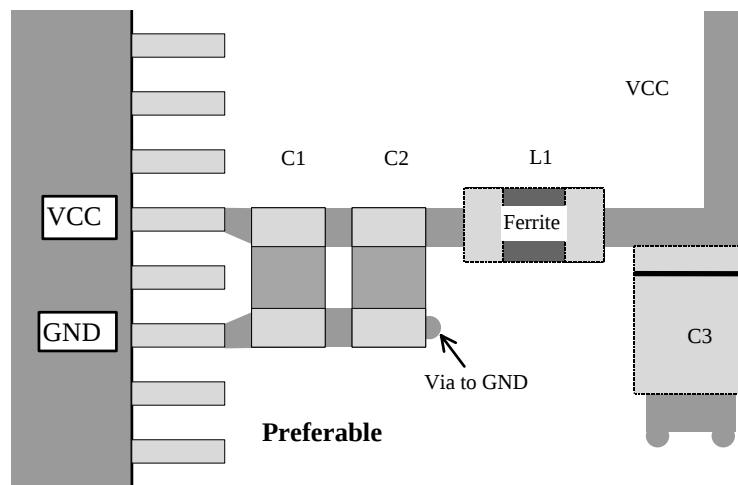


Figure 18. Decoupling and Bypass Capacitor Placement

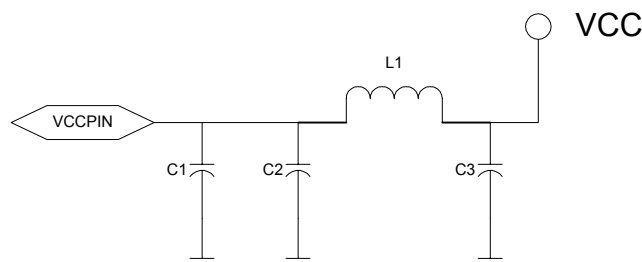


Figure 19. Decoupling and Bypass Schematic

Table 15. Recommended Components

| C1           | C2          | C3    | L1        |
|--------------|-------------|-------|-----------|
| 100 – 300 pF | 2.2 – 10 uF | 10 uF | 200+ ohms |

The values shown in Table 15 are recommendations that should be adjusted according to the noise characteristics of the specific board-level design. Pins in one group (such as OVCC) may share L1 and C3, each pin having C1 placed as closely to the pin as possible.

## Series Damping Resistors on Outputs

Series resistors are effective in lowering the data-related emissions and reducing reflections. Series resistors should be placed close to the output pins on the receiver chip, as shown in Figure 20.

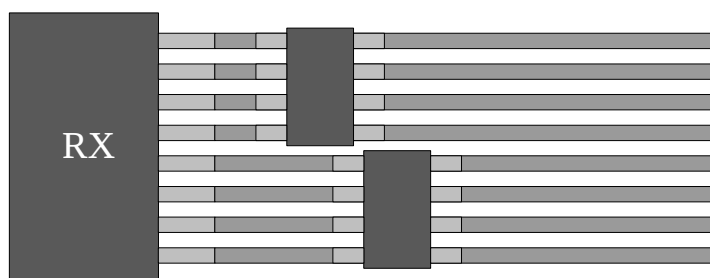


Figure 20. Receiver Output Series Damping Resistors

## Receiver Layout

Figure 21 to Figure 23 show an example routing of Dual Link for a DVI connector to the two SiI 163B's. The differential clock lines must be routed to the Slave receiver first, then to the Master receiver because of the way the internal impedance matching circuit is configured.

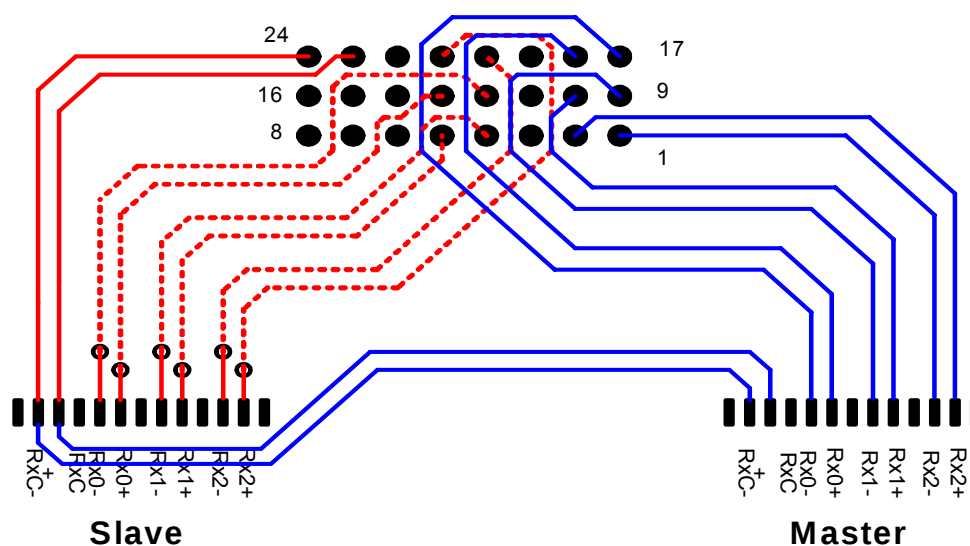


Figure 21. DVI Dual Link Rx PCB Routing Example – Top View

When operating as a Dual Link system, the two SiI 163B's must output their two data buses with synchronous timing. As described earlier, this is done by connecting DE from the Master to SYNC on the Slave. The length of the routed net from Master to Slave must be controlled to between 2.5 and 3.5 inches long. (This corresponds to a flight time of 400ps to 560ps, at a propagation velocity of 160ps per inch, typical of PCB layouts.)

Similarly, the connection to the differential clock, at Slave and Master, must use routed nets which are controlled in length. The 'stub' from the differential pair to the Slave RxC+ and RxC- pins must be less than 1.0 inch long (160ps). The differential pair from the start of the Slave's 'stub' to the Master's RxC+ and RxC- pins must be no longer than 3 inches long (~500ps). Pull down resistors to stabilize Slave SCDT output (shown on Figure 24) can be placed further from the Slave TMDS traces.

Differential routing or DE-to-SYNC routing longer than these limits will create a skew between Master and Slave which may exceed what can be corrected in the receivers' logic.

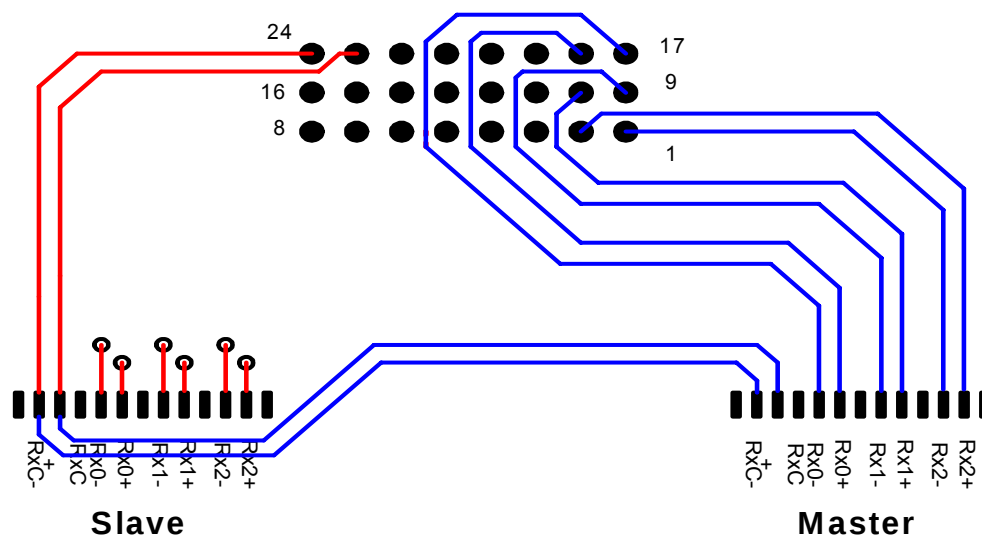


Figure 22. DVI Dual Link Rx PCB Routing Example – Top Signals Top View

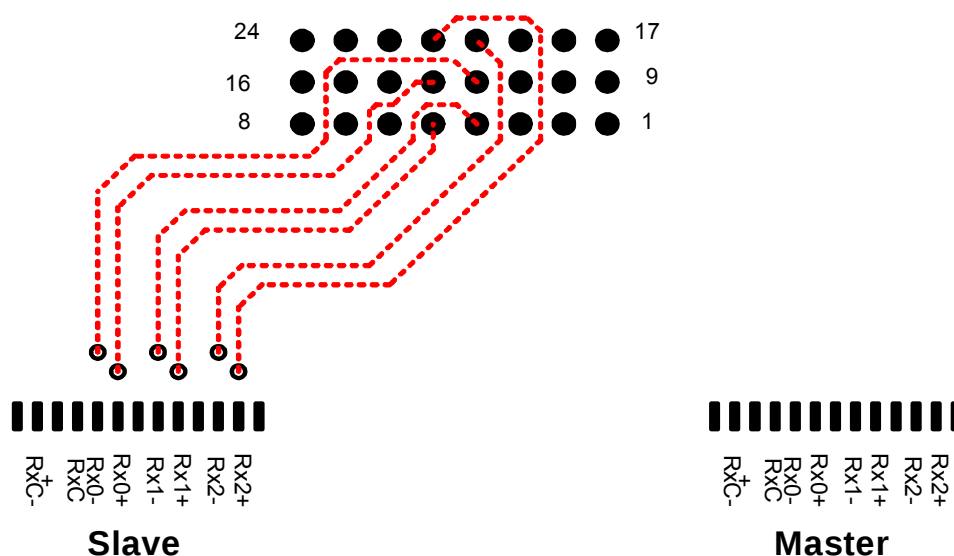


Figure 23. DVI Dual Link Rx PCB Routing Example - Bottom Signals Top View

The receiver chip should be placed as closely as possible to the input connector which carries the TMDS signals. For a system using the industry-standard DVI connector (see <http://www.ddwg.org>), the differential lines should be routed as directly as possible from connector to receiver. PanelLink devices are tolerant of skews between differential pairs, so spiral skew compensation for path length differences is not required. Each differential pair should be routed together, minimizing the number of vias through which the signal lines are routed.

As defined in the DVI 1.0 Specification, the impedance of the traces between the connector and the receiver should be 100 ohms differentially, and close to 50 ohms single-ended. The 100 ohm requirement is to best match the differential impedance of the cable and connectors, to prevent reflections. The common mode currents are very small on the TMDS interface, so differential impedance is more important than single-ended.

## Stabilized TMDS Inputs

The SCDT output of the slave SiI 163B receiver indicates the presence (or absence) of display data on the TMDS link. Both incoming TMDS clock and data will output a HIGH via SCDT indicating that the encoded DE signal and Clock from the TMDS transmitter is being detected and the link is active. In Dual Link mode the input Clock signal is shared between Master and Slave SiI 163B.

When functioning in Single Link (in a Dual Link application), input TMDS data for Slave SiI 163B is absent, SCDT output of the Slave SiI 163B will go low. However, system noise or coupled noise (above 20mV) can trigger the differential input circuits of the receiver falsely indicating that display data is being received. In this condition, the SiI 163B can assert SCDT High, even though the input data is invalid.

The SCDT output can be stabilized by introducing an offset voltage at the differential inputs. This can be achieved by adding pull down resistors to the appropriate inputs. A nominal value of 2K ohms provides sufficient offset between the + and – data differential inputs. In the application circuit, any value between 1.8K ohms and 2.5K ohms can be used with minimal effect on the single ended impedance.

Three pull down resistors should be placed on either the + or – differential data input pins. Figure 24 illustrates each + differential input data pin pulled down by a nominal 2K ohm resistor. The pull down resistors can be placed either close to the receiver or the DVI connector based on layout efficiency. Ensure that the trace leading to the resistor and ground is as short as possible to reduce capacitive loading. The TMDS Clock (RXC+ and RXC–) input pins do not require pull down resistors since they have internal pull down resistors.

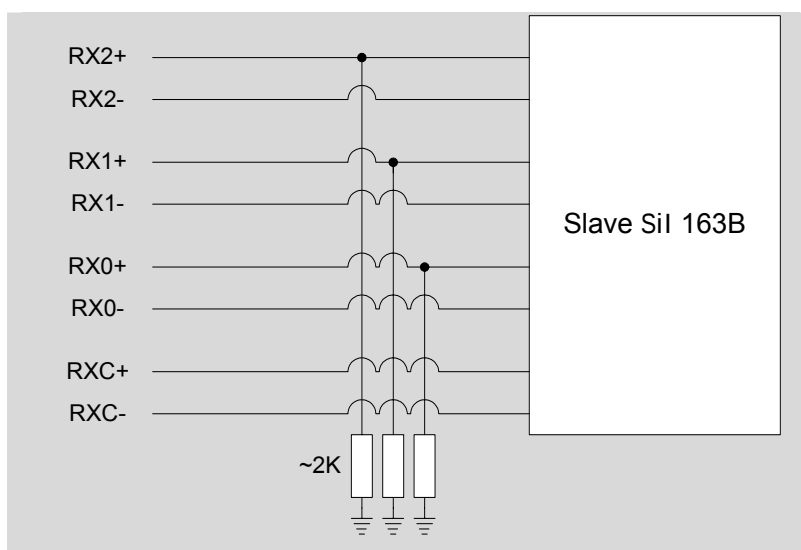


Figure 24. Stabilizing SCDT

## Staggered Outputs and Two Pixels per Clock

PanelLink receivers offer two features that can minimize the switching effects of the high-speed output data bus: two pixels per clock mode and staggered outputs.

The receiver can output one or two pixels in each output clock cycle. By widening the bus to two pixels per clock whenever possible, the clock speed is halved and the switching period of the data signals themselves is twice as long as in one pixel per clock mode. Typically, SXGA-resolution and above LCD panels expect to be connected with a 36-bit or 48-bit bus, two pixels per clock. Most XGA-resolution and below LCD panels use an 18- to 24-bit one pixel per clock interface.

When in two pixel per clock mode, the STAG\_OUT# pin on receivers provides an additional means of reducing simultaneous switching activity. When enabled (STAG\_OUT# = Low), only half of the output data pins switch together. The other half are switched one quarter clock cycle later. Note that both pixel buses use the same clock. Therefore, the staggered bus will have one quarter clock cycle less setup time to the clock, and one quarter clock cycle more hold time. Board designers driving into another clocked chip should take this into account in their timing analysis.

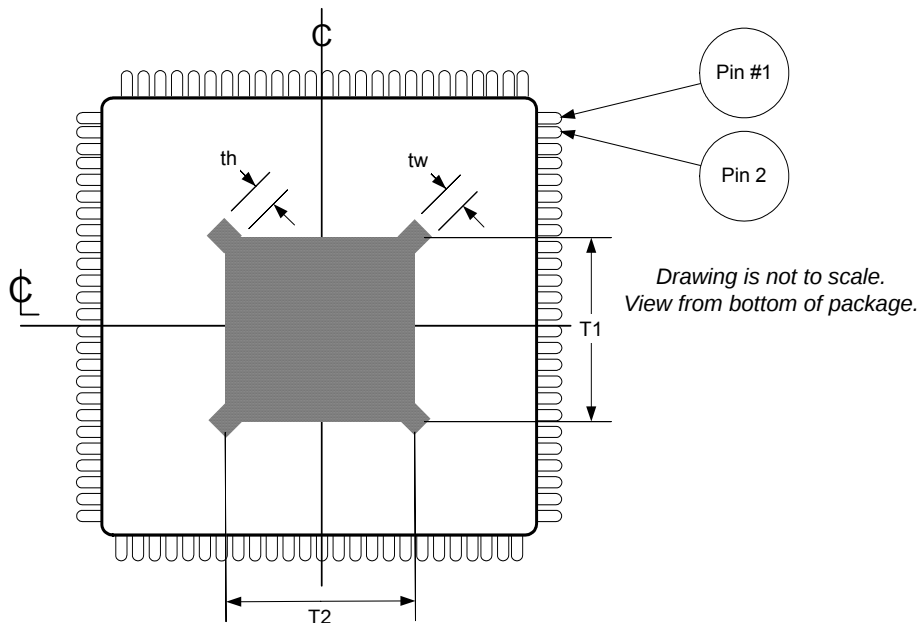
Silicon Image recommends the use of STAG\_OUT# and the two pixel per clock mode whenever possible.

Note that these features are limited when the SiI 163B is connected in Dual Link configuration.

## Packaging

### ePad Enhancement

The SiI163B is packaged in a 100-pin TQFP package with ePad. The ePad dimensions are shown in Figure 25.



|            |                       | typ | max       |
|------------|-----------------------|-----|-----------|
| T1         | ePad Height           |     | 6.5       |
| T2         | ePad Width            |     | 6.5       |
| tw         | ePad extension Width  | 0.3 | 0.4       |
| th         | ePad extension Length | 0.7 | 1.0       |
| $\Delta T$ | Tolerance             |     | $\pm 0.1$ |

All dimensions are in millimeters.  
ePad is centered on the package center lines with the tolerance shown.

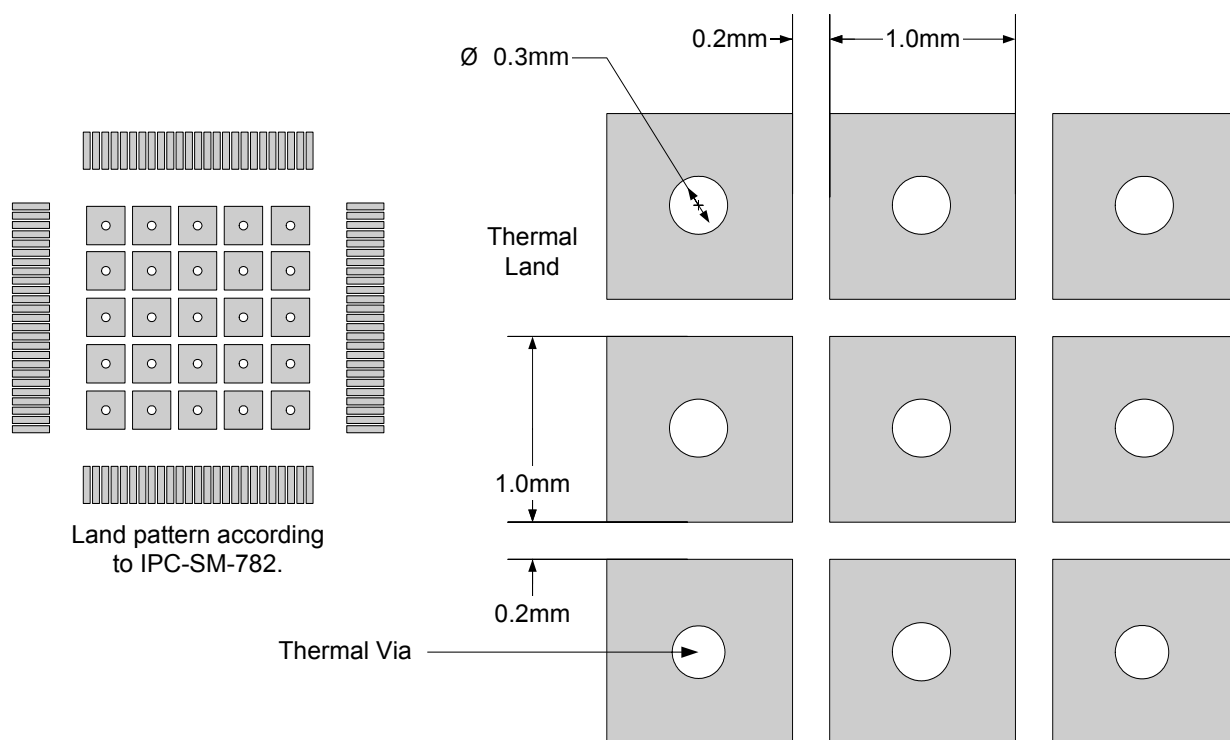
**Figure 25. ePad Diagram**

The ePad must not be electrically connected to any other voltage level except ground (GND). A clearance of at least 0.25mm should be designed on the PCB between the edge of the ePad and the inner edges of the lead pads to avoid any electrical shorts. Dimensions T1 and T2 define the maximum limit of ePad size. Protrusions from the edges of the ePad may vary slightly from one package assembler to another, but all are confined to within these maximum dimensions.

## PCB Thermal Land Area

The thermal land area on the PCB may use thermal vias to improve heat removal from the package. These thermal vias can double as ground connections, attaching internally in the PCB to the ground plane. An array of vias should be designed into the PCB beneath the package. For optimum thermal performance, it is recommended that the via diameter should be 12 to 13 mils (0.30 to 0.33mm) and the via barrel should be plated with 1 ounce copper to plug the via. This is desirable to avoid any solder wicking inside the via during the soldering process, which may result in voids in solder between the exposed pad and the thermal land. If the copper plating does not plug the vias, the thermal vias can be 'tented' with solder mask on the top surface of the PCB to avoid solder wicking inside the via during assembly. The solder mask diameter should be at least 4 mils (0.1mm) larger than the via diameter.

Package stand-off is also a consideration. For a nominal stand-off of 0.1mm (see Figure 27, dimension 'A1'), the stencil thickness of 5 to 8 mils should provide a good solder joint between the ePad and the thermal land. The aperture opening should be subdivided into an array of smaller openings.



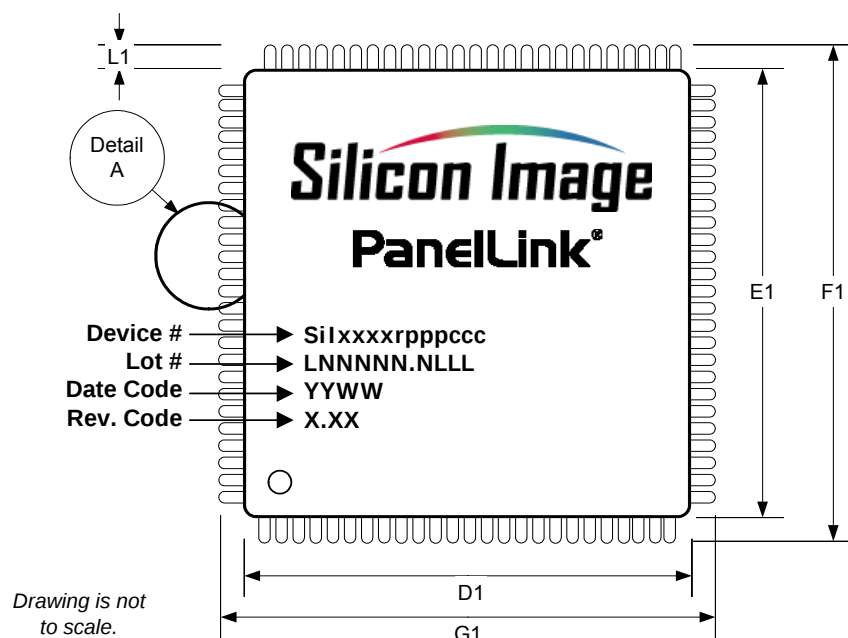
**Figure 26. ePad Template Layout**

For improved heat transfer, the exposed ePad should be soldered to the thermal land on the PCB. This requires solder paste application not only on the pin pad pattern, but also on the thermal land using a stencil. The stencil thickness is a function of the lead pitch, package coplanarity and stencil dimensions. For a nominal package standoff of 0.1mm, a stencil with 5 to 8 mil thickness should provide a good solder joint between the ePad and the thermal land.

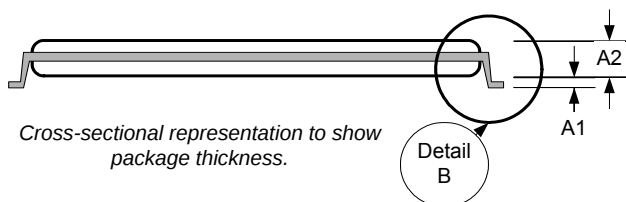
The thermal land is covered with a passivation layer, with openings corresponding to each of the metal rectangles. For improved solder release, the land area should be subdivided into smaller shapes, coordinated with the pitch and size of the thermal vias. *The drawing in Figure 26 is representational.* Such a structure should result in a solder joint area of 80% to 90% of the ePad area. To achieve the specified thermal performance, at least 70% of the ePad should be soldered to the thermal land.

## 100-pin TQFP Package Dimensions and Marking Specification

JEDEC Package Code MS026AED-HD

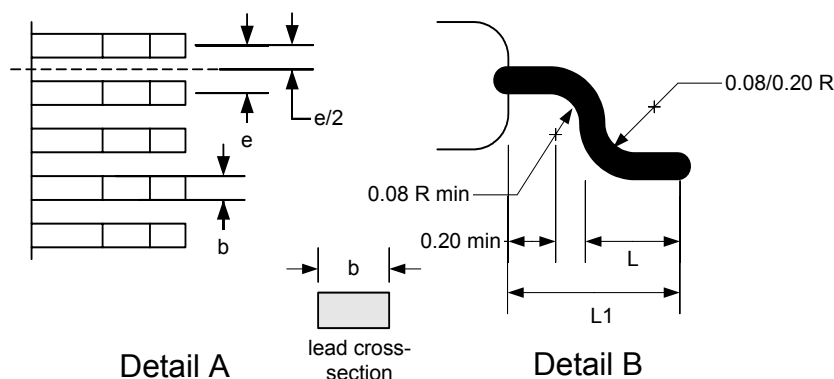
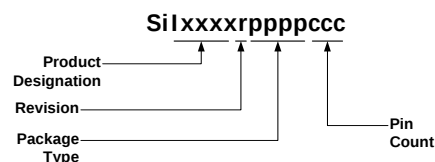


Drawing is not to scale.  
Pin count is representative.  
Refer to product specifications.



|    |                | typ   | max   |
|----|----------------|-------|-------|
| A  | Thickness      |       | 1.20  |
| A1 | Stand-off      |       | 0.15  |
| A2 | Body Thickness | 1.00  | 1.05  |
| D1 | Body Size      | 14.00 | 14.00 |
| E1 | Body Size      | 14.00 | 14.00 |
| F1 | Footprint      | 16.00 | 16.00 |
| G1 | Footprint      | 16.00 | 16.00 |
|    | Lead Count     | 100   | —     |
| L1 | Lead Length    | 1.00  | —     |
| L  | Lead Foot      | 0.60  | 0.75  |
| b  | Lead Width     | 0.20  | 0.27  |
| e  | Lead Pitch     | 0.50  | —     |

Dimensions in millimeters.  
Overall thickness A=A1+A2.



Universal Package:  
SiI163BCTG100

| Legend     | Description |
|------------|-------------|
| LNNNNN.NLL | Lot Number  |
| L          |             |
| YY         | Year of Mfr |
| WW         | Week of Mfr |
| Rev Code   | X.XX        |

Figure 27. Package Dimensions and Marking Specification

### Marking Specification

Marking drawing is not to scale. Pin counts are representative and may not match the pin count of this product.

### Ordering Information

Production Part Number:

SiI163BCTG100

## Summary of Changes

The following table lists the major changes to this document up to the present revision.

| Revision | Date    | Pages        | Changes                                                     |
|----------|---------|--------------|-------------------------------------------------------------|
| A        | 03/2002 | —            | Original release.                                           |
| B        | 08/2004 | 3, 32, 33-34 | Added ePad description. Slave SCDT Stabilization guideline. |
| C        | 07/2005 | 33           | Fixed ePad dimensions. Part ordering number updated         |

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